

High-Performance Dual-Channel DC-DC Converter

General Description

DA9122 is a power management unit (PMU) suitable for supplying CPUs, GPUs, DDR memory rails in single in-line pin package (SIPP) modules, smartphones, tablets, and other handheld applications.

DA9122 integrates two single-phase buck converters, each phase requiring a small external 0.10 μ H inductor. Each buck is capable of delivering up to 5 A output current at a 0.3 V to 1.9 V output voltage range. The 2.5 V to 5.5 V input voltage range is suitable for a wide variety of low-voltage systems, including, but not limited to, all Li-Ion battery supplied applications.

With remote sensing, the DA9122 guarantees the highest accuracy and supports multiple PCB routing scenarios without loss of performance.

The pass devices are fully integrated, so no external FETs or Schottky diodes are needed.

A programmable soft start-up can be enabled, which limits the inrush current from the input node and secures a slope-controlled rail activation.

The dynamic voltage control (DVC) supports adaptive adjustment of the supply voltage dependent on the processor load, via either a direct register write using the communication interface (I²C-compatible) or with a programmable input pin.

A configurable GPI allows multiple I²C address selection for multiple instances of DA9122 in the same application.

DA9122 has integrated over-temperature and over-current-protection for increased system reliability, without the need for external sensing components.

Key Features

- 2.5 V to 5.5 V input voltage
- 0.3 V to 1.9 V output voltage
- 4 MHz nominal switching frequency
- ± 1 % accuracy (static)
- ± 5 % accuracy (dynamic)
- I²C-compatible interface (FM+)
- Programmable GPIOs
- Programmable soft-start
- Voltage, current, and temperature supervision
- -40 °C to +85 °C ambient temperature range
- Package:
24WLCSP 2.5 mm x 1.7 mm (0.4 mm pitch)

Applications

- SIPP modules (SoC, DRAM)
- Smartphones
- Tablet PCs
- Infotainment
- Ultrabooks™
- Wi-Fi -Modules
- Game Consoles

System Diagrams

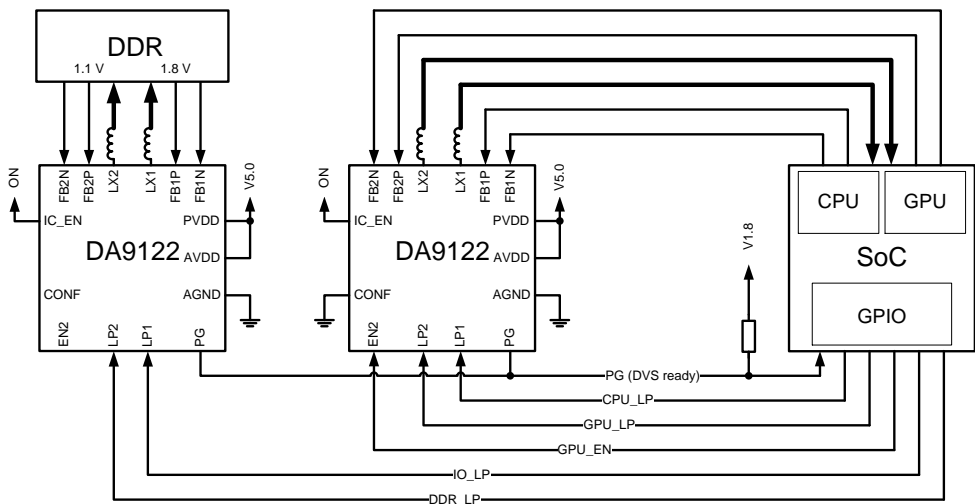


Figure 1: Typical Application Diagram (Port Control)

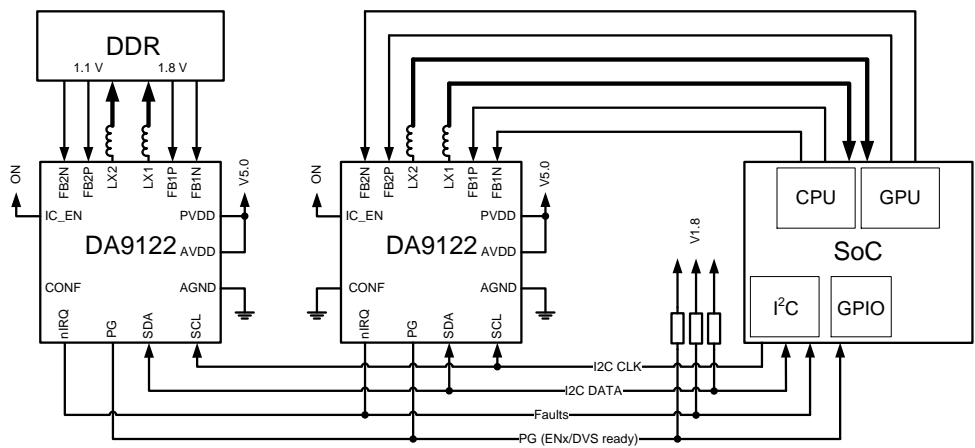


Figure 2: Typical Application Diagram (I²C Control)

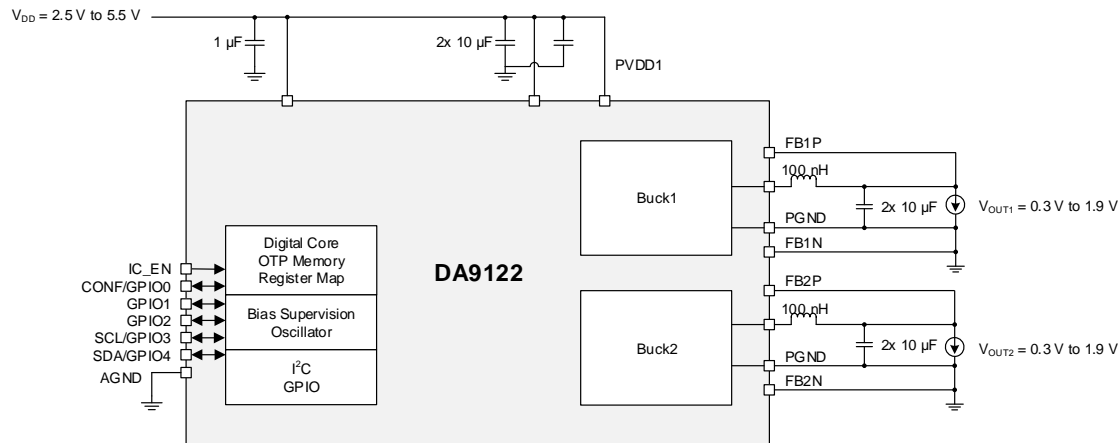


Figure 3: Simplified Schematic Diagram

High-Performance Dual-Channel DC-DC Converter

Contents

General Description	1
Key Features	1
Applications	1
System Diagrams	2
1 Terms and Definitions.....	5
2 Pinout	6
3 Characteristics	8
3.1 Absolute Maximum Ratings	8
3.2 Recommended Operating Conditions.....	8
3.3 Thermal Characteristics	9
3.3.1 Thermal Ratings	9
3.3.2 Power Dissipation	9
3.4 ESD Characteristics	9
3.5 Buck Characteristics	11
3.6 Performance and Supervision Characteristics.....	12
3.7 Digital I/O Characteristics.....	13
3.8 Timing Characteristics.....	14
3.9 Typical Performance	15
4 Functional Description	19
4.1 DC-DC Buck Converter.....	19
4.1.1 Switching Frequency	19
4.1.2 Operation Modes and Phase Selection	19
4.1.3 Output Voltage Selection	20
4.1.4 Soft Start-Up and Shutdown	20
4.1.5 Current Limit	20
4.1.6 Thermal Protection	21
4.2 Internal Circuits	22
4.2.1 IC_EN/Chip Enable/Disable	22
4.2.2 nIRQ/Interrupt	22
4.2.3 GPIO	27
4.3 Operating Modes.....	Error! Bookmark not defined.
4.3.1 ON.....	30
4.3.2 OFF.....	30
4.4 I ² C Communication	30
4.4.1 I ² C Protocol.....	31
5 Register Definitions	33
5.1 Register Map	33
5.1.1 System	35
5.1.2 Buck1	45
5.1.3 Buck2	49
5.1.4 Serialization	53
6 Package Information	54
6.1 Package Outlines	54

High-Performance Dual-Channel DC-DC Converter

6.2	Moisture Sensitivity Level.....	55
6.3	WLCSP Handling	55
6.4	Soldering Information	55
7	Ordering Information	56
8	Application Information	56
8.1	Capacitor Selection	56
8.2	Inductor Selection	57
	Revision History	58

1 Terms and Definitions

ATE	Automated test equipment
CPU	Central processing unit
DDR	Dual data rate
DVC	Dynamic voltage control
FET	Field effect transistor
FM+	Fast mode plus
GBD	Guaranteed by design
GBQ	Guaranteed by qualification
GBSPC	Guaranteed by statistical process characterization
GPI	General purpose input
GPIO	General purpose input/output
GPU	Graphics processing unit
IC	Integrated circuit
HW	Hardware
Li-Ion	Lithium-ion
OTP	One time programmable
PCB	Printed circuit board
PRS	Product requirements specification
SCL	Serial clock
SDA	Serial data
SIPP	Single in-line pin package
SW	Software

High-Performance Dual-Channel DC-DC Converter

2 Pinout

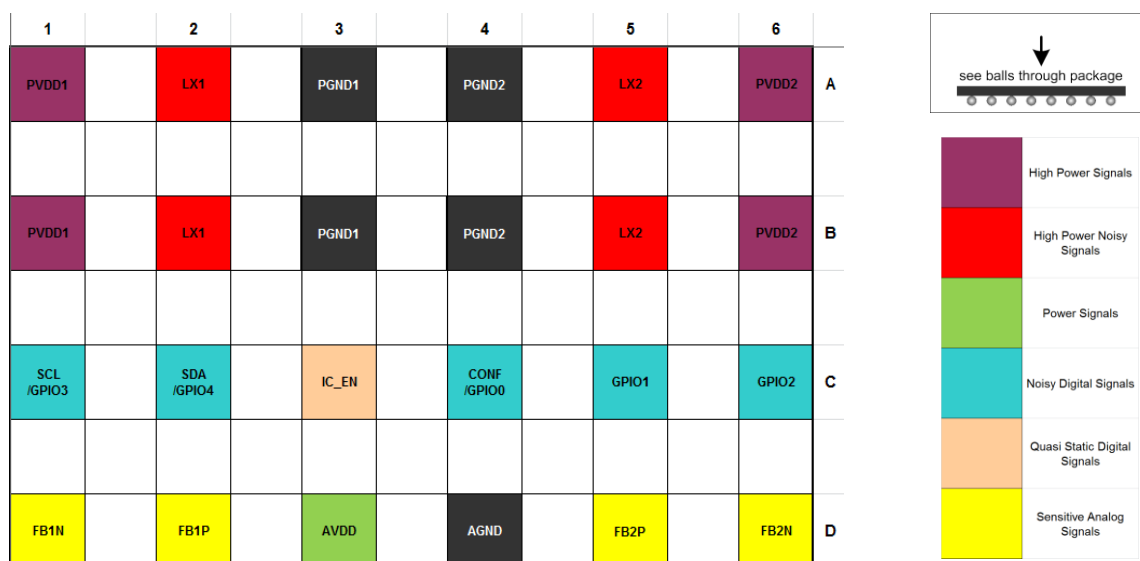


Figure 4: DA9122 Pinout Diagram (Top View)

Table 1: Pin Description

Pin No.	Pin Name	Type (Table 2)	Drive (mA)	Reset State	Description
A1, B1	PVDD1	PWR	5000		Supply voltage for Buck1 power stage, decouple with 10 μ F and connect to same source as AVDD
A2, B2	LX1	AIO	5000		Switch node of Buck1, connect a 100 nH inductor between LX1 and output capacitor
A3, B3	PGND1	GND	5000		Buck1 power stage VSS rail
A4, B4	PGND2	GND	5000		Buck2 power stage VSS rail
A5, B5	LX2	AIO	5000		Switch node of Buck2, connect a 100 nH inductor between LX2 and output capacitor
A6, B6	PVDD2	PWR	5000		Supply voltage for Buck2 power stage, decouple with 10 μ F and connect to same source as AVDD
C1	SCL/GPIO3	DIO	15		I ² C clock or general purpose I/O
C2	SDA/GPIO4	DIO	15		I ² C data or general purpose I/O
C3	IC_EN	AI	10		Powers up SW control interface and auxiliary circuitry (for example, bandgap, oscillator, and references).
C4	CONF/GPIO0	AI/DIO	10		Chip configuration or general purpose I/O
C5	GPIO1	DIO	10		General purpose I/O
C6	GPIO2	DIO	10		General purpose I/O
D1	FB1N	AI	10		Buck1 negative node of differential voltage feedback, connect to VSS at point of load
D2	FB1P	AI	10		Buck1 positive node of differential voltage feedback, connect to V _{OUT1} at point of load

High-Performance Dual-Channel DC-DC Converter

Pin No.	Pin Name	Type (Table 2)	Drive (mA)	Reset State	Description
D3	AVDD	PWR	10		Supply rail for analog control circuitry, decouple with 1 μ F and connect to same source as PVDD
D4	AGND	GND	10		Analog control and auxiliary circuitry VSS
D5	FB2P	AI	10		Buck2 positive node of differential voltage feedback, connect to V _{OUT2} at point of load
D6	FB2N	AI	10		Buck2 negative node of differential voltage feedback, connect to VSS at point of load

Table 2: Pin Type Definition

Pin Type	Description	Pin Type	Description
DI	Digital input	AI	Analog input
DO	Digital output	AO	Analog output
DIO	Digital input/output	AIO	Analog input/output
PWR	Power	GND	Ground

High-Performance Dual-Channel DC-DC Converter

3 Characteristics

3.1 Absolute Maximum Ratings

Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, so functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specification are not implied. Exposure to Absolute Maximum Rating conditions for extended periods may affect device reliability.

Table 3: Absolute Maximum Ratings

Parameter	Description	Conditions	Min	Max	Unit
T _{STG}	Storage temperature		-65	150	°C
T _J	Junction temperature		-40	150	°C
V _{SYS}	System supply voltage		-0.3	6.0	V
V _{PIN}	Voltage on pins		-0.3	6.0	V

3.2 Recommended Operating Conditions

Table 4: Recommended Operating Conditions

Parameter	Description	Conditions (Note 1)	Min	Typ	Max	Unit
V _{SYS}	System supply voltage		2.5		5.5	V
V _{PIN}	Voltage on pins		-0.3		V _{SYS} + 0.3	V
T _J	Junction temperature		-40		125	°C
T _A	Ambient temperature		-40		85	°C

Note 1 Within the specified limits, a lifetime of 10 years is guaranteed. If operating outside of these recommended conditions, please consult with Dialog Semiconductor.

High-Performance Dual-Channel DC-DC Converter

3.3 Thermal Characteristics

3.3.1 Thermal Ratings

Table 5: Package Ratings

Parameter	Description	Conditions	Min	Typ	Max	Unit
θ_{JA}	Package thermal resistance Note 1			32.7		°C/W

Note 1 Obtained from package thermal simulation, 2S2P4L board (JEDEC), influenced by PCB technology and layout.

3.3.2 Power Dissipation

Table 6: Power Dissipation

Parameter	Description	Conditions	Min	Typ	Max	Unit
P_D	Power dissipation	Derating factor above $T_A = 70^\circ\text{C}$: $30.6 \text{ mW}/^\circ\text{C}$ ($1/\theta_{JA}$)		2140		mW

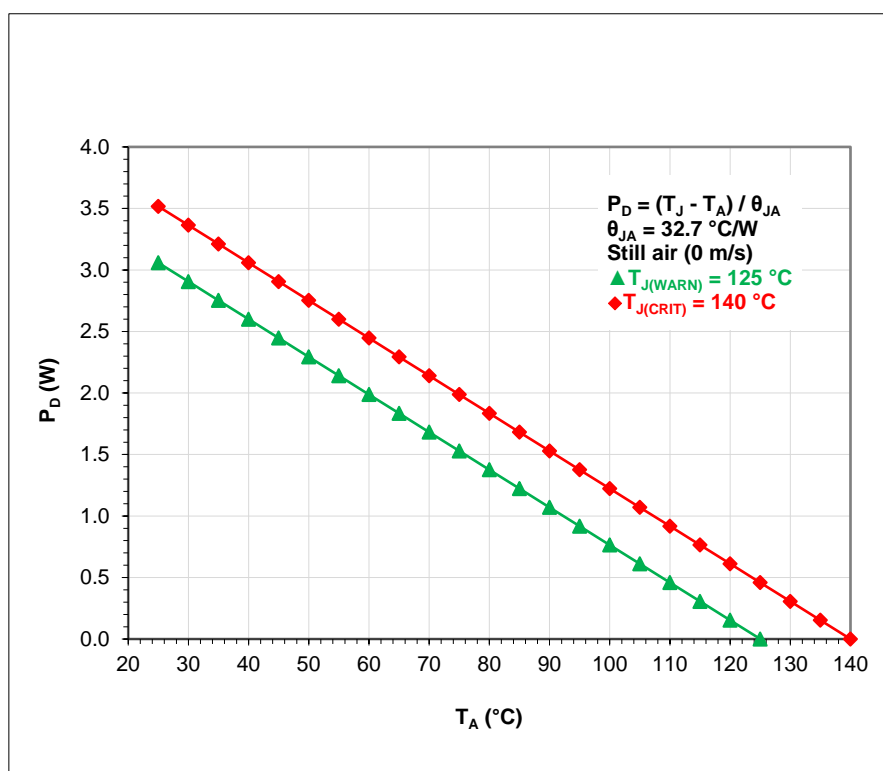


Figure 5: 24WLCSP Power Derating Curve

3.4 ESD Characteristics

Table 7: ESD Characteristics

Parameter	Description	Conditions	Min	Typ	Max	Unit
V_{ESD_HBM}	ESD protection, human body model (HBM)				2	kV

High-Performance Dual-Channel DC-DC Converter

3.5 Buck Characteristics

Unless otherwise noted, the following is valid for $T_J = -40\text{ }^{\circ}\text{C}$ to $+125\text{ }^{\circ}\text{C}$, $V_{SYS} = 2.5\text{ V}$ to 5.5 V

Table 8: Buck Electrical Characteristics

Parameter	Description	Conditions	Min	Typ	Max	Unit
External Electrical Conditions						
V_{IN}	Input voltage	$V_{IN} = V_{SYS}$	2.5		5.5	V
C_{OUT}	Output capacitance, per phase, including voltage and temperature coefficient		-40 %	2×10	+30 %	μF
ESR_{COUT}	Output capacitor series resistance, per phase	$f > 100\text{ kHz}$		2		m Ω
L	Inductor value, per phase, including current and temperature dependence		-50 %	0.1	+20 %	μH
DCR_L	Inductor DC resistance			30	50	m Ω
Electrical Performance						
V_{OUT}	Output voltage, programmable in 10 mV steps	$I_{OUT} = 0\text{ mA}$ to I_{MAX} $V_{IN} = 2.5\text{ V}$ to 5.5 V	0.3		1.57	V
V_{OUT_LIM}	Output voltage, programmable in 10 mV steps	$I_{OUT} = 0\text{ mA}$ to I_{MAX} $V_{IN} = 3.0\text{ V}$ to 5.5 V	0.3		1.9	V
I_{LIM}	Current limit, programmable per phase Note 1	$CHx_ILIM = 1010$	-20 %	8	+20 %	A
V_{OUT_ACC}	Output voltage accuracy, including static line and load regulation	$V_{OUT} \geq 1\text{ V}$	-1		1	%
V_{OUT_ACC}	Output voltage accuracy, including static line and load regulation	$V_{OUT} < 1\text{ V}$	-10		10	mV
$V_{THR_PG_RISE}$	Power good voltage threshold for rising	Referred to V_{OUT}	-80	-50	-20	mV
$V_{THR_PG_DWN}$	Power good voltage threshold for falling	Referred to V_{OUT}	-160	-130	-100	mV
V_{THR_HV}	High V_{OUT} voltage threshold	Referred to V_{OUT}	100	150	200	mV
$V_{OUT_TR_LINE}$	Line transient response	$V_{IN} = 3\text{ V}$ to 3.6 V $I_{OUT} = 0.5 \times I_{MAX}$ $dt = 10\text{ }\mu\text{s}$		15		mV
f_{SW}	Switching frequency, post-trim			4		MHz

High-Performance Dual-Channel DC-DC Converter

Parameter	Description	Conditions	Min	Typ	Max	Unit
t _{ON_MIN}	Minimum turn-on pulse 0 % duty is also supported			20		ns
t _{BUCK_EN}	Turn-on time	CHx_EN = high			20	μs
R _{PD}	Output pull-down resistance for each phase at the LX node, see CHx_PD_DIS	V _{IN} = 3.7 V, V _{OUT} = 0.5 V	100	150	200	Ω
R _{ON_Pmos}	On resistance of switching PMOS, per phase	V _{IN} = 3.7 V		36		mΩ
R _{ON_Nmos}	On resistance of switching NMOS, per phase	V _{IN} = 3.7 V		17		mΩ
AUTO Mode						
V _{OUT_TR_LD_1PH}	Load transient response	1-phase V _{OUT} = 1 V I _{OUT} = 0 A to 5 A dI/dt = 10 A/μs		±5		%
PFM Mode						
I _{Q_PFM_1PH}	Quiescent current in PFM	1-phase V _{IN} = 3.7 V No load No switching		88		μA

Note 1 t_{ON} > 40 ns

3.6 Performance and Supervision Characteristics

Table 9: Electrical Characteristics

Parameter	Description	Conditions	Min	Typ	Max	Unit
Electrical Performance						
V _{THR_POR}	Power-on-reset threshold	Threshold for AVDD falling		2.1	2.25	V
V _{THR_POR_HYS}	Power-on-reset hysteresis			200		mV
T _{WARN}	Thermal warning temperature threshold		115	125	135	°C
T _{CRIT}	Thermal shutdown temperature threshold		130	140	150	°C
I _{IN_OFF}	Supply current	OFF state T _A = 27 °C IC_EN = 0		0.1	1	μA

High-Performance Dual-Channel DC-DC Converter

Parameter	Description	Conditions	Min	Typ	Max	Unit
I _{IN_ON}	Supply current	ON state T _A = 27 °C IC_EN = 1 Buck off	5	10	20	μA

3.7 Digital I/O Characteristics

Table 10: Digital I/O Electrical Characteristics

Parameter	Description	Conditions	Min	Typ	Max	Unit
Electrical Performance						
V _{IH_EN}	Input high voltage, IC enable		1.2		AVDD	V
V _{IL_EN}	Input low voltage, IC enable				0.4	V
t _{IC_EN}	IC enable time				1000	μs
V _{IH_GPIO_SCL_SDA}	Input high voltage GPIO, SCL, SDA		1.2		AVDD	V
V _{IL_GPIO_SCL_SDA}	Input low voltage GPIO, SCL, SDA				0.4	V
V _{OH_GPIO}	Output high voltage GPIO	Push-pull mode I _{OUT} = 1 mA	0.8*AVDD		AVDD	V
V _{OL_GPIO}	Output low voltage GPIO	Push-pull mode I _{OUT} = 1 mA			0.2*AVDD	V
V _{OL_SDA}	Output low voltage SDA	I _{OUT} = 3 mA		0.24		V
R _{PD}	GPIO pull-down resistor		2	10	120	kΩ
R _{PU}	GPIO pull-up resistor		2	10	120	kΩ

High-Performance Dual-Channel DC-DC Converter

3.8 Timing Characteristics

Table 11: I2C Electrical Characteristics

Parameter	Description	Conditions	Min	Typ	Max	Unit
Electrical Performance						
t _{BUS}	Bus free time between a STOP and START condition		0.5			μs
C _{BUS}	Bus line capacitive load				150	pF
f _{SCL}	SCL clock frequency		20 Note 1		1000	kHz
t _{LO_SCL}	SCL low time		0.5			μs
t _{HI_SCL}	SCL high time		0.26			μs
t _{RISE}	SCL and SDA rise time	Requirement for input			1000	ns
t _{FALL}	SCL and SDA fall time	Requirement for input			300	ns
t _{SETUP_START}	Start condition setup time		0.26			μs
t _{HOLD_START}	Start condition hold time		0.26			μs
t _{SETUP_STOP}	Stop condition setup time		0.26			μs
t _{DATA}	Data valid time				0.45	μs
t _{DATA_ACK}	Data valid acknowledge time				0.45	μs
t _{SETUP_DATA}	Data setup time		50			ns
t _{HOLD_DATA}	Data hold time		0			ns

Note 1 Minimum clock frequency is limited to 20 kHz if I2C_TIMEOUT is enabled

High-Performance Dual-Channel DC-DC Converter

3.9 Typical Performance

Unless otherwise noted, $V_{IN} = 3.7\text{ V}$, $V_{OUT} = 1.0\text{ V}$, $T_A = 25\text{ }^{\circ}\text{C}$, 2.0 mm x 1.6 mm 0.1 μH output inductor (DCR = typ. 11.5 m Ω) and 2 x 10 μF output capacitors per-channel.

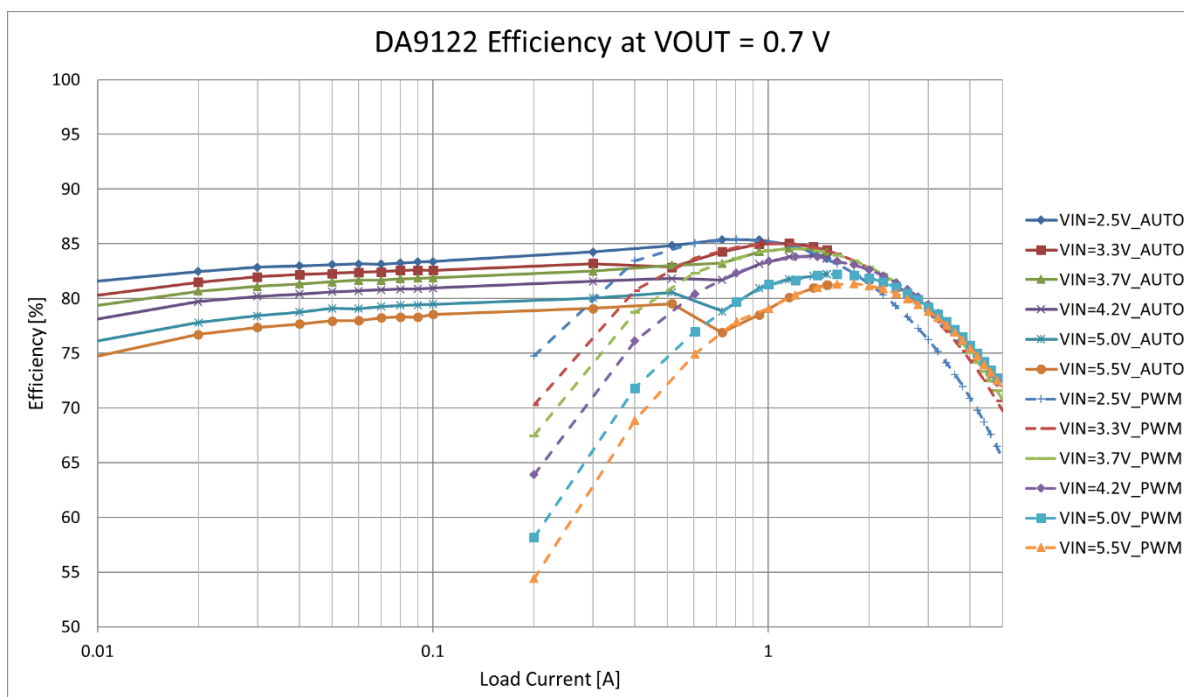


Figure 6: Efficiency vs Load, $V_{OUT} = 0.7\text{ V}$

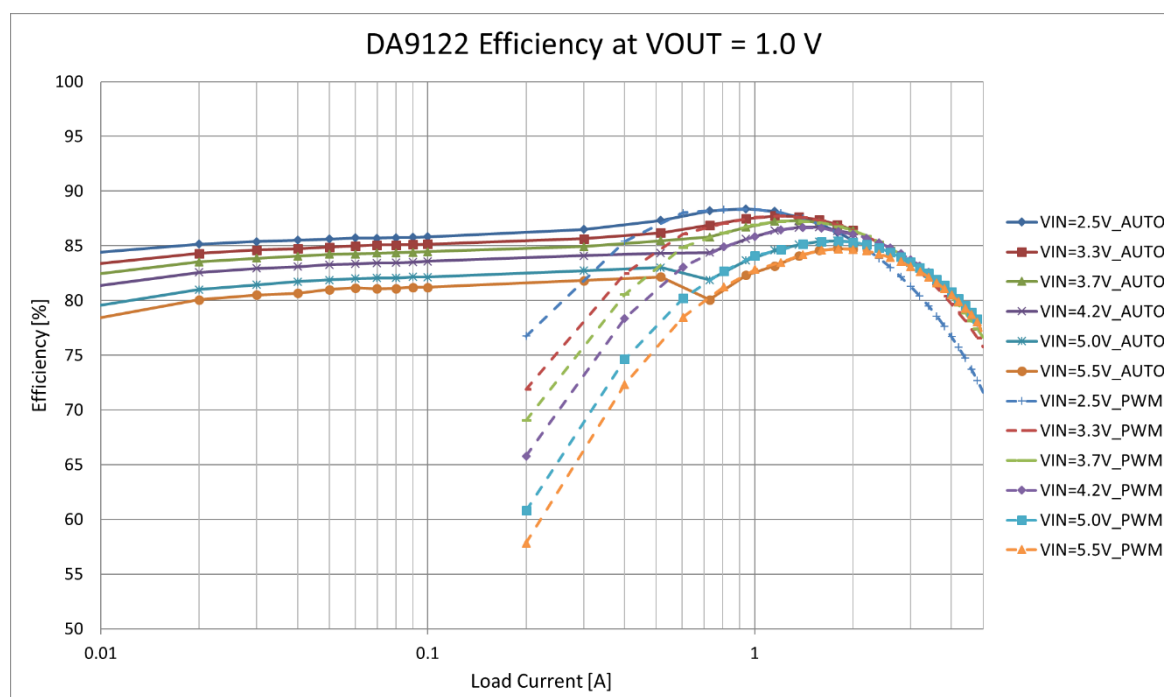
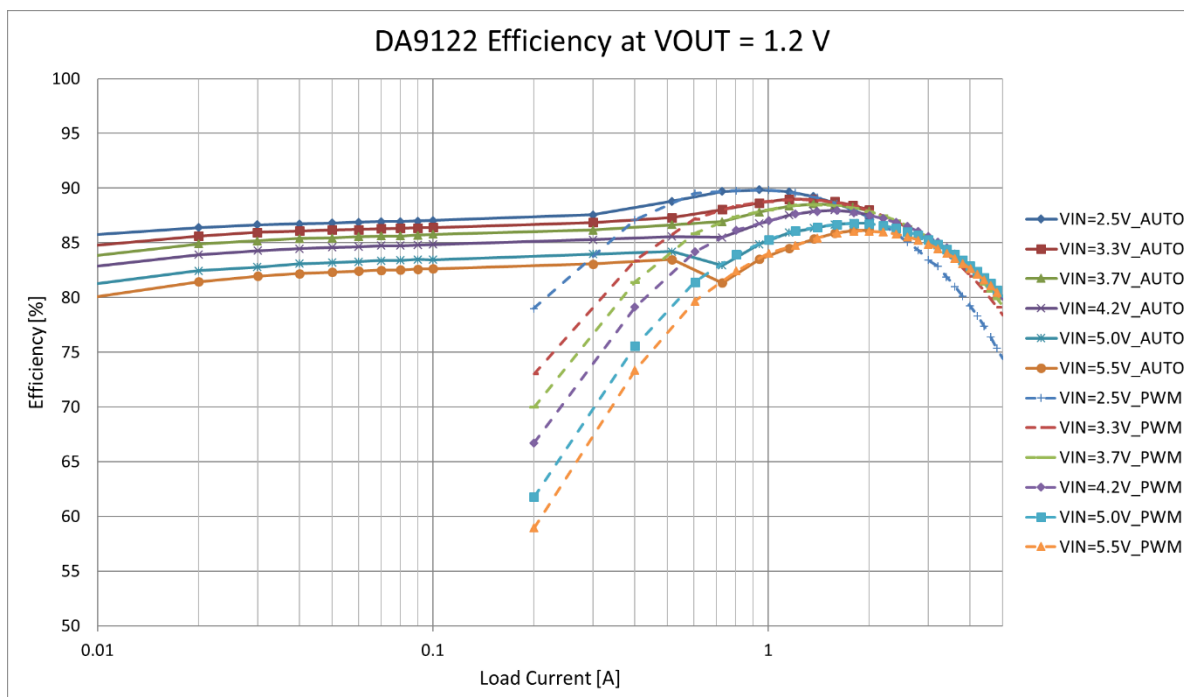
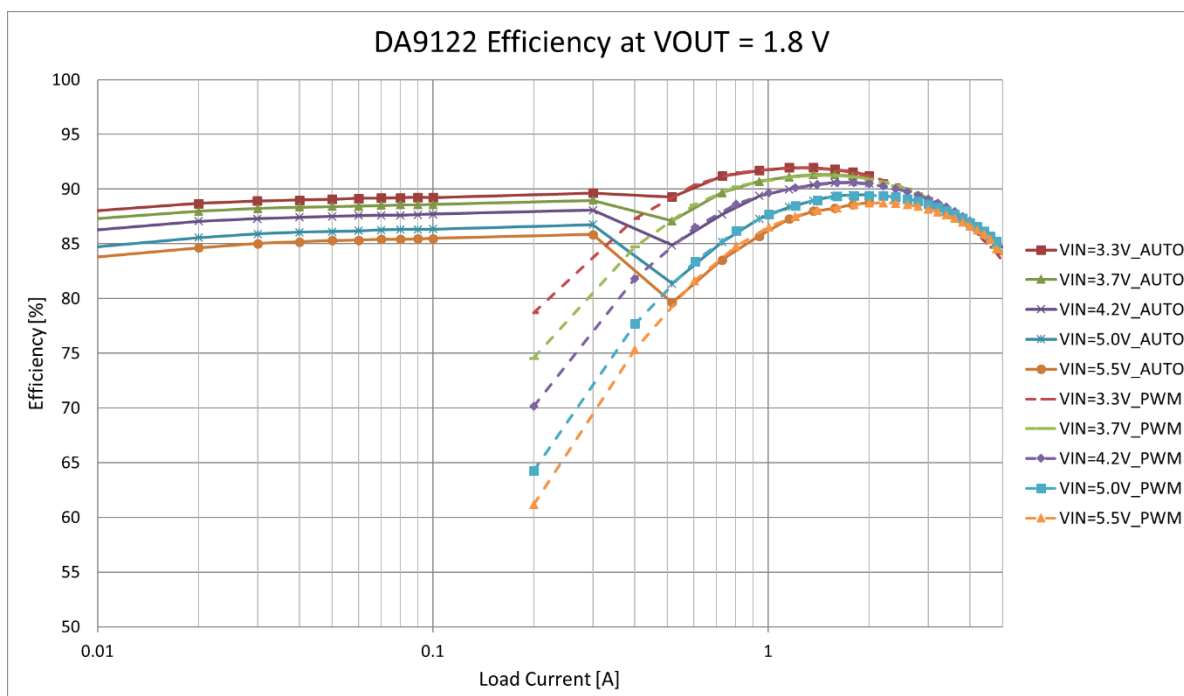


Figure 7: Efficiency vs Load, $V_{OUT} = 1.0\text{ V}$

High-Performance Dual-Channel DC-DC Converter

Figure 8: Efficiency vs Load, $V_{OUT} = 1.2\text{ V}$ Figure 9: Efficiency vs Load, $V_{OUT} = 1.8\text{ V}$

High-Performance Dual-Channel DC-DC Converter

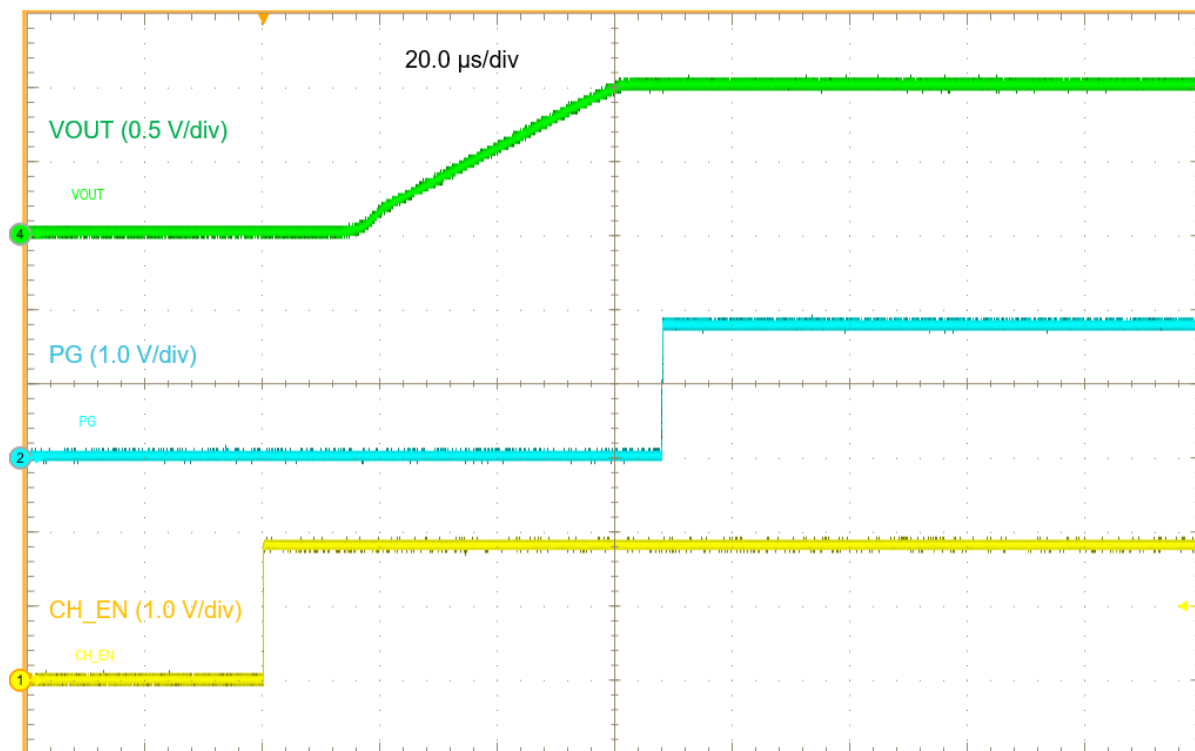


Figure 10: Buck SoftStart-up at 20 mV/μs Slew Rate

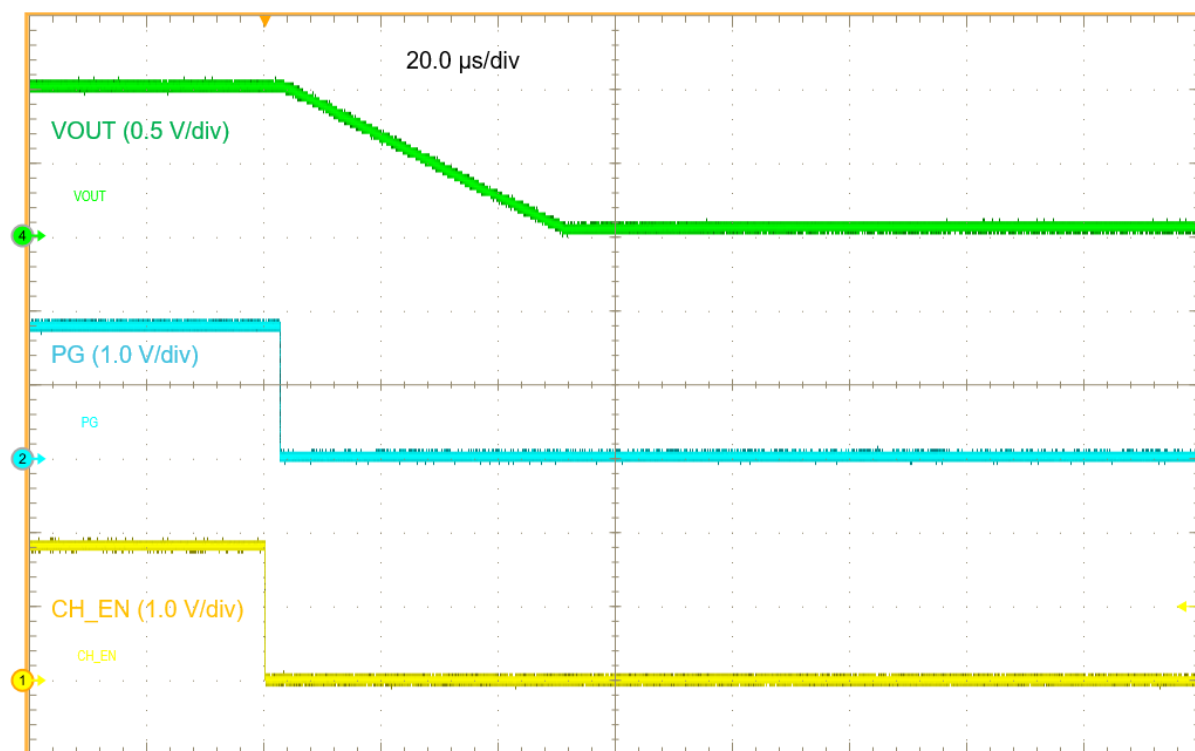


Figure 11: Buck Active Shutdown at 20 mV/μs Slew Rate

High-Performance Dual-Channel DC-DC Converter

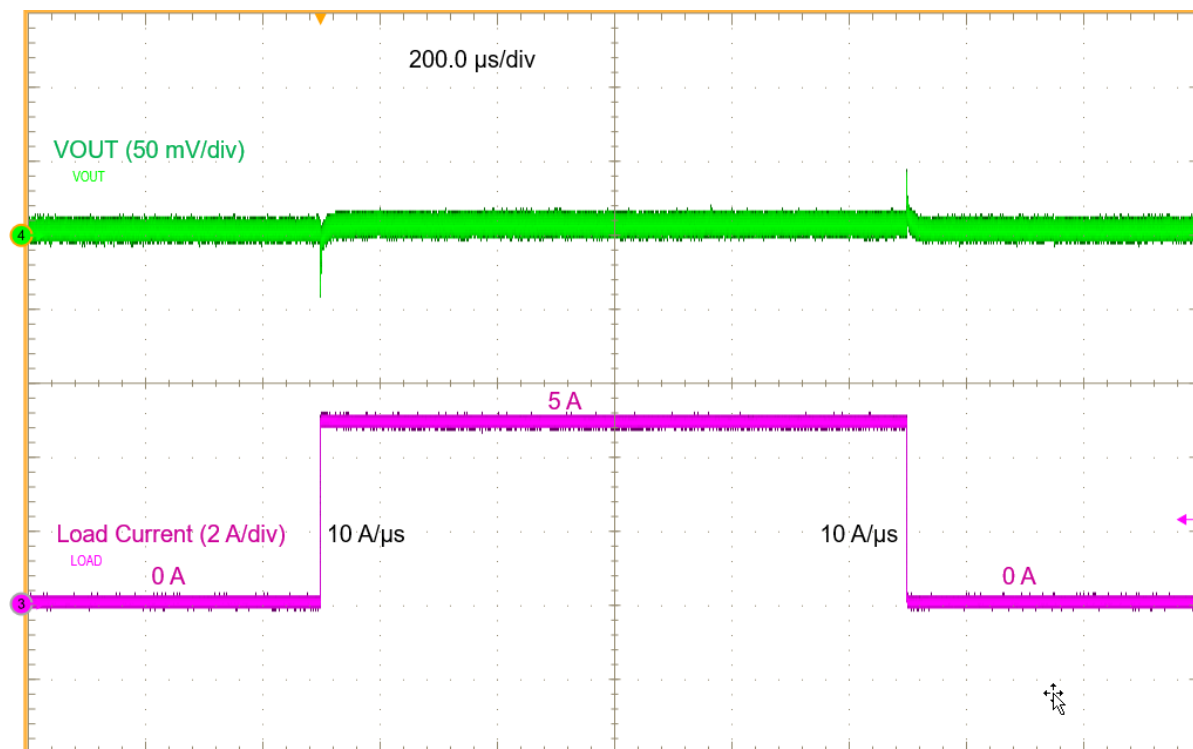


Figure 12: Buck Load Transient Response in Forced PWM Mode, 0 A to 5 A at 10 A/μs

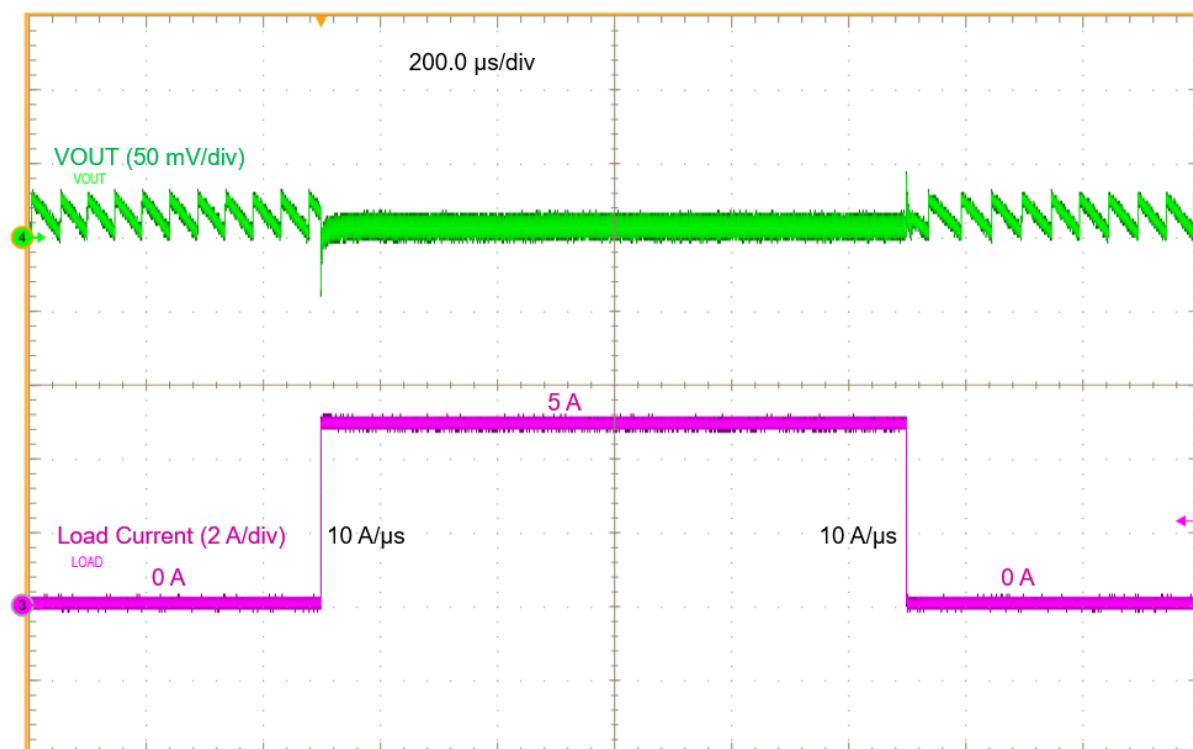


Figure 13: Buck Load Transient Response in AUTO Mode, 0 A to 5 A at 10 A/μs

High-Performance Dual-Channel DC-DC Converter

4 Functional Description

4.1 DC-DC Buck Converter

DA9122 contains two buck converters, Buck1 and Buck2, each capable of delivering up to 5 A output current at a 0.3 V to 1.9 V output voltage range.

Buck1 and Buck2 have two voltage registers each. One defines the normal output voltage, while the other offers an alternative retention voltage. In this way, different application power modes can easily be supported. The voltage selection can be operated either via GPI or via control interface to guarantee the maximum flexibility according to the specific host processor status in the application.

When a buck is enabled, its output voltage is monitored and a power good signal indicates that the buck output voltage has reached a level higher than the $V_{THR_PG_RISE}$ threshold. The power good status is lost when the voltage drops below $V_{THR_PG_DWN}$ or increases above V_{THR_HV} . For each of the buck converters the status of the power good indicator can be read back via I²C from the PG1 and PG2 status bits. It can be also individually assigned to any of the GPIOs by setting the GPIO mode registers to either PG1 or PG2 output.

The buck converters are capable of supporting DVC transitions that occur:

- When the active and selected A- or B-voltage is updated to a new target value.
- When the voltage selection is changed from the A- to B-voltage (or B- to A-voltage) using CH<x>_VSEL.

The DVC controller operates in pulse width modulation (PWM) mode with synchronous rectification.

The slew rate of the DVC transition is individually programmed for each buck converter at 10 mV per 8 μ s, 4 μ s, 2 μ s, 1 μ s, or 0.5 μ s in register bits CH1_SR_DVC and CH2_SR_DVC.

A pull-down resistor (typically 150 Ω) for each phase is always activated unless it is disabled by setting register bits CH<x>_PD_DIS to 1.

4.1.1 Switching Frequency

The buck switching frequency can be tuned using register bit OSC_TUNE. The internal 8 MHz oscillator frequency is tuned in ± 160 kHz steps. This impacts the buck converter frequency in steps of 80 kHz and helps to mitigate possible disturbances to other high frequency systems in the application.

4.1.2 Operation Modes and Phase Selection

The buck converters can operate in PWM and PFM modes. The operating mode is selected using register bits CH1_<A or B>_MODE and CH2_<A or B>_MODE.

If the automatic operation mode is selected on CH1_<A or B>_MODE or CH2_<A or B>_MODE, the buck converters automatically change between synchronous PWM mode and PFM depending on the load current. This improves the efficiency across the whole range of output load currents.

High-Performance Dual-Channel DC-DC Converter

4.1.3 Output Voltage Selection

The switching converter can be configured using the I²C interface.

For each buck converter two output voltages can be pre-configured in registers CH<x>_A or B>_VOUT. The output voltage can be selected by either toggling register bit CH<x>_VSEL or by re-programming the selected voltage control register. Both changes will result in ramped voltage transitions. After being enabled, the buck converter will, by default, use the register settings in CH<x>_A_VOUT unless the output voltage selection is configured via the GPI port.

Registers CH<1 and 2>_VMAX limit the output voltage that can be set for each of the respective buck converters.

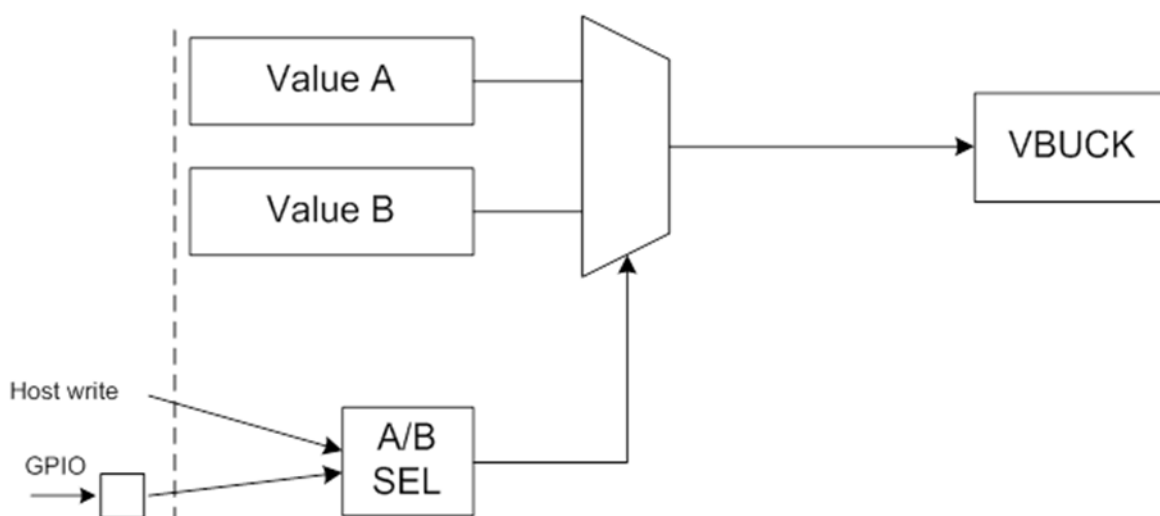


Figure 14: Buck Output Voltage Control Concept

4.1.4 Soft Start-Up and Shutdown

To limit in-rush current from V_{SY}, the buck converters can perform a soft-start after being enabled. The start-up behavior is a compromise between acceptable inrush current from the battery and turn-on time. Individual ramp times can be configured for each buck converter in registers CH<1 and 2>_SR_STARTUP respectively. Rates higher than 20 mV/μs may produce overshoot during the start-up phase, so they should be considered carefully.

A ramped power down can be selected in register bits CH<1 and 2>_SR_SHDN. When no ramp is selected (immediate power down), the output node will be discharged only by the pull-down resistor, if enabled in registers CH<1 and 2>_PD_DIS.

4.1.5 Current Limit

The integrated current limit protects the power stages and external coil from excessive current. The buck current limit should be configured to at least 40 % higher than the required maximum output current.

When the current limit is reached, each buck converter generates an event and an interrupt to the host processor unless the interrupt has been masked using register M_OC<x> in SYS_MASK_1. Register bits OC_DVC_MASK is used to mask over-current events during DVC transitions.

High-Performance Dual-Channel DC-DC Converter

4.1.6 Thermal Protection

DA9122 is protected from internal overheating by thermal shutdown.

There are two kinds of flags concerning thermal protection, thermal warning and thermal critical. The warning flag is asserted when $T_J > T_{WARN}$ and the critical flag is asserted when $T_J > T_{CRIT}$. When the critical flag is asserted, Buck1 and 2 are shut down immediately.

Table 12: Thermal Protection Control Registers

Category	Register name	Description
Status	TEMP_WARN	Asserted as long as the thermal warning threshold is reached
	TEMP_CRIT	Asserted as long as the thermal shutdown threshold is reached
IRQ event	E_TEMP_WARN	TEMP_WARN caused event
	E_TEMP_CRIT	TEMP_CRIT caused event
IRQ mask	M_TEMP_WARN	TEMP_WARN event IRQ mask
	M_TEMP_CRIT	TEMP_CRIT event IRQ mask
	M_VR_HOT	TEMP_WARN status IRQ mask

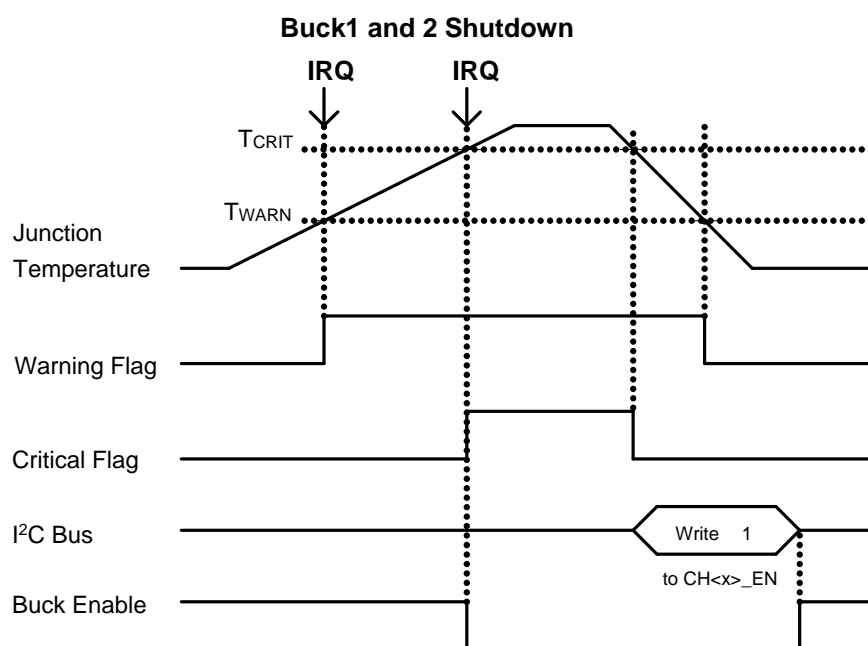


Figure 15: Thermal Protection Operation

High-Performance Dual-Channel DC-DC Converter

4.2 Internal Circuits

4.2.1 IC_EN/Chip Enable/Disable

IC_EN is chip enable/disable control input. When IC_EN = 0, all blocks except for low I_Q POR are powered-down and buck output is pulled-down.

4.2.2 nIRQ/Interrupt

The interrupt triggers events. Trigger conditions and control registers for each interrupt event are listed in Table 13.

Some of these events are categorized as fault events and affect device operation (for example, buck disable), see Section 4.1.6.

Table 13: Interrupt List

Name	Polarity (Note 1)	Trigger	IRQ Status Register	IRQ Mask Register	Deglintch Period
Thermal warning (event)	N	T _J rising above T _{WARN}	E_TEMP_WARN	M_TEMP_WARN	0 s
Thermal critical (event)	N	T _J rising above T _{CRIT}	E_TEMP_CRIT	M_TEMP_CRIT	0 s
System good (event)	P		E_SG	M_SG	0 s
Buck1 power-good (event)	P	Buck1 V _{OUT} is in power-good voltage range (not under- or over-voltage)	E_PG1	M_PG1	0 s
Buck2 power-good (event)	P	Buck2 V _{OUT} is in power-good voltage range (not under- or over-voltage)	E_PG2	M_PG2	0 s
Buck1 over-voltage (event)	N	Buck1 V _{OUT} rising above over-voltage threshold (target voltage + 150 mV)	E_OV1	M_OV1	Rise:8 μs Fall:8 μs
Buck2 over-voltage (event)	N	Buck2 V _{OUT} rising above over-voltage threshold (target voltage + 150 mV)	E_OV2	M_OV2	Rise:8 μs Fall:8 μs
Buck1 under-voltage (event)	N	Buck1 V _{OUT} falling below under-voltage threshold (target voltage - V _{TH_PG})	E_UV1	M_UV1	0 s
Buck2 under-voltage (event)	N	Buck2 V _{OUT} falling below under-voltage threshold (target voltage - V _{TH_PG})	E_UV2	M_UV2	0 s

High-Performance Dual-Channel DC-DC Converter

Name	Polarity (Note 1)	Trigger	IRQ Status Register	IRQ Mask Register	Deglitch Period
Buck1 over- current (event)	N	Buck1 current rising above over-current threshold	E_OC1	M_OC1	0 s
Buck2 over- current (event)	N	Buck2 current rising above over-current threshold	E_OC2	M_OC2	0 s
Buck1 power- good (status) (Note 2)	P	Buck1 V _{OUT} is in power- good voltage range (not under- or over-voltage)	PG1	M_PG1_STAT (Note 3)	0 s
Buck2 power- good (status) (Note 2)	P	Buck2 V _{OUT} is in power- good voltage range (not under- or over-voltage)	PG2	M_PG2_STAT (Note 3)	0 s
System good (status) (Note 2)	P		SG	M_SG_STAT (Note 3)	0 s
Thermal warning (status) (Note 2)	N	T _J rising above T _{WARN}	TEMP_WARN	M_VR_HOT (Note 3)	0 s
GPIO0 change (event)	N	Detect GPIO0 change for active trigger selected GPIO0_TRIG register	E_GPIO0	M_GPIO0	100 μs/ 1 ms/ 10 ms/ 100 ms
GPIO1 change (event)	N	Detect GPIO1 change for active trigger selected GPIO1_TRIG register	E_GPIO1	M_GPIO1	
GPIO2 change (event)	N	Detect GPIO2 change for active trigger selected GPIO2_TRIG register	E_GPIO2	M_GPIO2	

Note 1 Polarity at the source of the flag: P = active-high, N = active-low.

General rule is: normal system state is high, and abnormal system state is low (for example, PG = high means power-good, TEMP_CRIT = low when TEMP critical state).

Note 2 Interrupt outputs the status as is. I²C write is not required for interrupt clear.

Note 3 OTP load value defined by CONF pin setting if CONF_EN = 1.

High-Performance Dual-Channel DC-DC Converter

Table 14: Interrupt Registers Except for Power Good Status

Register	Description
E_<name>	Read-only interrupt event register 0: No interrupt 1: Interrupt occurred Cleared after being written to I²C. Set until IRQ is removed.
M_<name>	Interrupt mask register 0: Not masked 1: Masked. No IRQ signal sent. Event register (E_<name>) is updated.

Table 15: Interrupt Registers for Power Good, System Good, and Temp Warning Status

Register	Description
PG<x>	Buck<x> power good status. Asserted as long as the buck<x> output voltage is in range (under-voltage threshold < buck output voltage < over-voltage threshold) 0: Not power good 1: Power good
M_PG<x>_STAT	Power good status interrupt mask register 0: Not masked 1: Masked. No IRQ signal sent. Power good status register (PG<x>) is updated
SG	System good status 0: Not system good 1: System good
M_SG_STAT	System good status (SG) interrupt mask register 0: Not masked 1: Masked. No IRQ signal sent. System good status register (SG) is updated
TEMP_WARN	Asserted as long as the thermal warning threshold (T _{WARN}) is reached 0: Junction temperature is below T _{WARN} 1: Junction temperature is above T _{WARN}
M_VR_HOT	Temperature warning status (TEMP_WARN) interrupt mask register 0: Not masked 1: Masked. No IRQ signal sent. Temperature warning status register (TEMP_WARN) is updated

High-Performance Dual-Channel DC-DC Converter

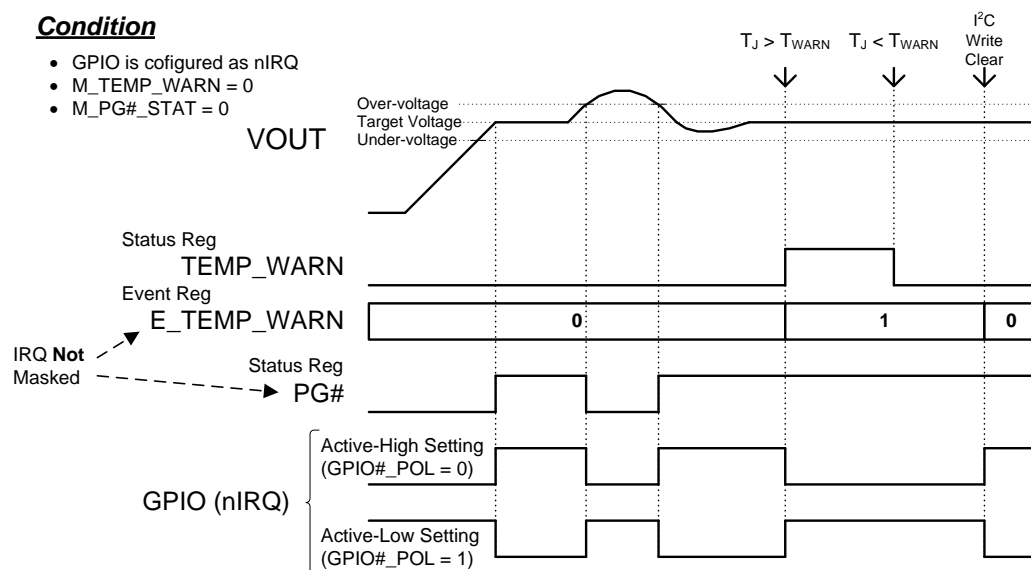


Figure 16: Interrupt Operation Example 1

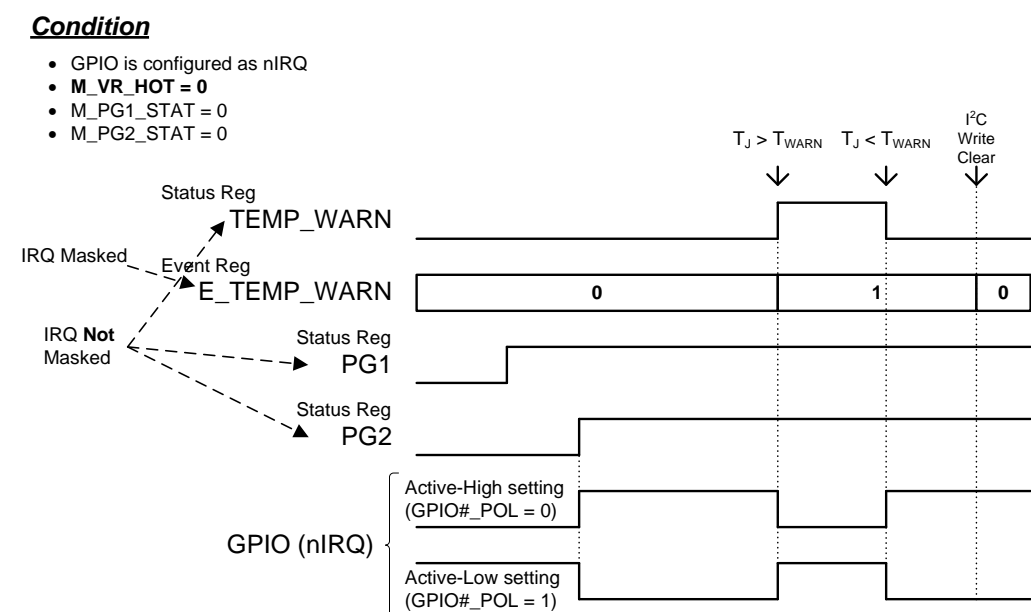


Figure 17: Interrupt Operation Example 2

High-Performance Dual-Channel DC-DC Converter

Condition

- GPIO is configured as nIRQ
- **M_SG = 0**

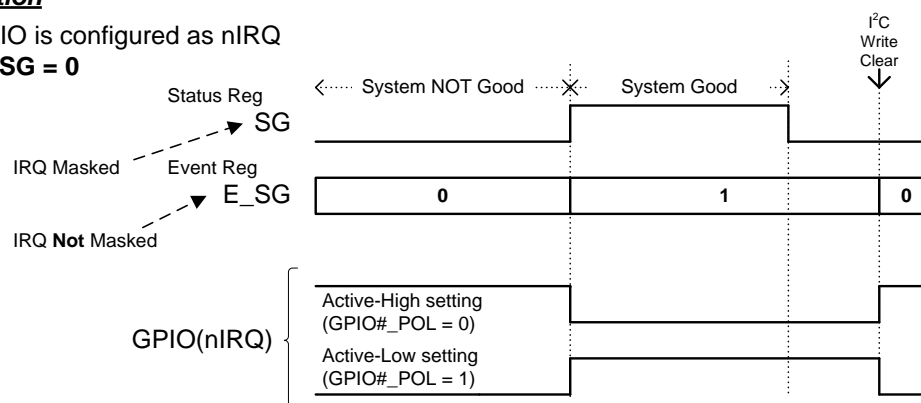


Figure 18: Interrupt Operation Example 3

Condition

- GPIO is configured as nIRQ
- **M_SG_STAT = 0**

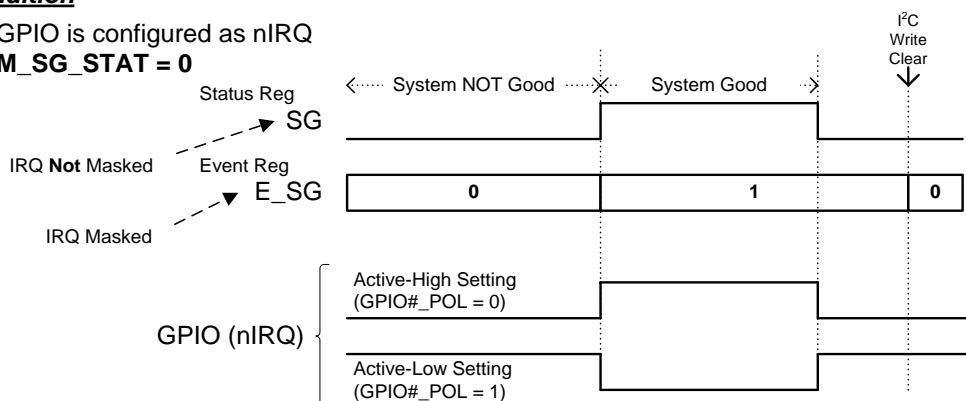


Figure 19: Interrupt Operation Example 4

High-Performance Dual-Channel DC-DC Converter

4.2.3 GPIO

4.2.3.1 GPIO Pin Assignment

The DA9122 provides up to five GPIO pins, three if the I²C is enabled, see Table 16. These registers are OTP programmable. When CONF_EN = 1 GPIO0 can be used for chip configuration.

Any register settings for GPIO3 and GPIO4 are ignored and GPIO3 and GPIO4 function as SCL and SDA respectively if I2C_EN = 1.

Table 16: GPIO Pin Assignment

OTP Option		GPIO Pin					Available GPIOs
I2C_EN	CONF_EN	CONF/ GPIO0	GPIO1	GPIO2	SCL/ GPIO3	SDA/ GPIO4	
1'b0	1'b0	GPIO0	GPIO1	GPIO2	GPIO3	GPIO4	5
	1'b1	CONF	GPIO1	GPIO2	GPIO3	GPIO4	4
1'b1	1'b0	GPIO0	GPIO1	GPIO2	SCL	SDA	3
	1'b1	CONF	GPIO1	GPIO2	SCL	SDA	2

4.2.3.2 GPIO Function

The GPIOs pins are configurable as the following functions in register GPIO<x>_MODE (x = 0 to 4):

- Buck1 enable input (EN1)
- Buck2 enable input (EN2)
- Buck1 and Buck2 enable input (EN1 & EN2)
- Buck1 DVC control input (DVC1)
- Buck2 DVC control input (DVC2)
- Buck1 and Buck2 DVC control input (DVC1 & DVC2)
- Buck1 and Buck2 OTP setting reload input (RELOAD)
- Buck1 power good output (PG1)
- Buck2 power good output (PG2)
- Buck1 power good and Buck2 power good output (PG1 & PG2)
- System good output (SG)
- Interrupt output (nIRQ)

Table 17: GPIO Function Configuration

GPIO<x>_MODE[3:0]	Function	IO Condition
4'h0	GPIO disable	HiZ
4'h1	EN1	In
4'h2	EN2	In
4'h3	EN1 & EN2	In
4'h4	DVC1	In
4'h5	DVC2	In
4'h6	DVC1 & DVC2	In
4'h7	RELOAD	In
4'h8	PG1	Out

High-Performance Dual-Channel DC-DC Converter

GPIO<x>_MODE[3:0]	Function	IO Condition
4'h9	PG2	Out
4'hA	PG1 & PG2	Out
4'hB	SG	Out
4'hC	nIRQ	Out
4'hD	Reserved	HiZ
4'hE	Low level	Out
4'hF	High level	Out

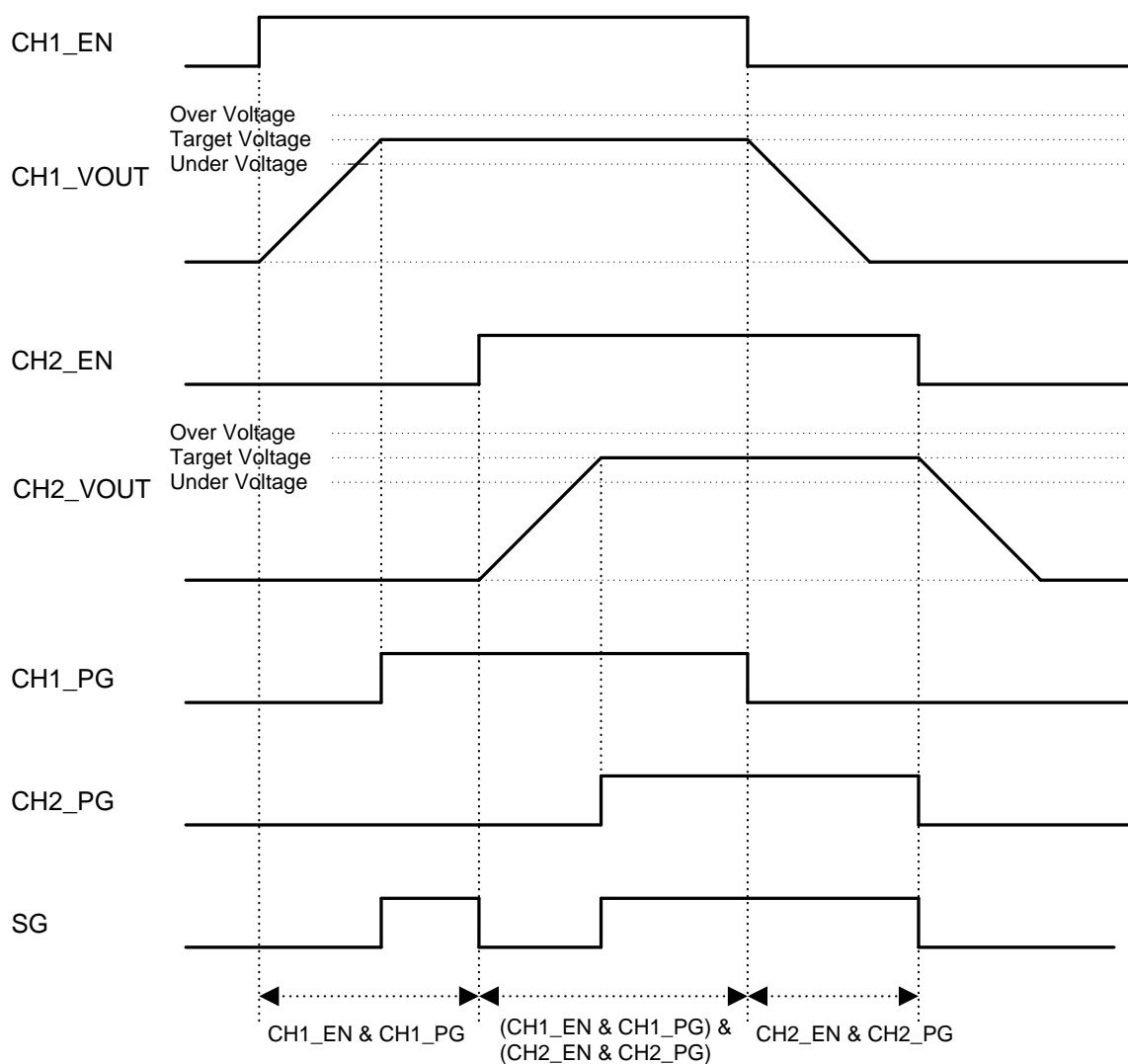


Figure 20: Power Good (PG) and System Good (SG)

High-Performance Dual-Channel DC-DC Converter

4.2.3.3 Chip Configuration Select (CONF)

GPIO0 functions as chip configuration select (CONF) input when CONF_EN = 1.

Three different chip configurations can be selected according to the CONF pin level, whether it is HIGH, LOW, or Hi-Z.

Table 18: GPIO0-Configurable Registers when CONF_EN = 1

Register Name	Description
IF_SLAVE_ADDR[6:0]	I2C slave address
CH1_A_MODE[1:0]	CH1_A Operation mode select
CH1_B_MODE[1:0]	CH1_B Operation mode select
CH1_VSEL	CH1 output voltage and operation selection
CH1_EN	CH1 enable
CH1_A_VOUT[7:0]	CH1 output voltage setting A
CH1_B_VOUT[7:0]	CH1 output voltage setting B
CH2_A_MODE[1:0]	CH2_A Operation mode select
CH2_B_MODE[1:0]	CH2_B Operation mode select
CH2_VSEL	CH2 output voltage and operation selection
CH2_EN	CH2 enable
CH2_A_VOUT[7:0]	CH2 output voltage setting A
CH2_B_VOUT[7:0]	CH2 output voltage setting B
M_PG1_STAT	IRQ mask setting for CH1 power good status
M_PG2_STAT	IRQ mask setting for CH2 power good status
M_SG_STAT	IRQ mask setting for system good status
M_VR_HOT	IRQ mask setting for temp warning status
CH1_EN_DLY[3:0]	Delay setting for CH1 enable
CH1_DIS_DLY[3:0]	Delay setting for CH1 disable
CH2_EN_DLY[3:0]	Delay setting for CH2 enable
CH2_DIS_DLY[3:0]	Delay setting for CH2 disable
GPIO1_MODE[3:0]	GPIO1 mode setting
GPIO2_MODE[3:0]	GPIO2 mode setting
GPIO1_OBUF	GPIO1 output buffer select
GPIO2_OBUF	GPIO2 output buffer select
GPIO1_TRIG[1:0]	GPIO1 input trigger select
GPIO1_POL	GPIO1 polarity select
GPIO1_PUPD	GPIO1 pull-up/pull-down enable
GPIO1_DEB[1:0]	GPIO1 input debounce time setting
GPIO1_DEB_RISE	GPIO1 input debounce rising edge enable
GPIO1_DEB_FALL	GPIO1 input debounce falling edge enable
GPIO2_TRIG[1:0]	GPIO2 input trigger select
GPIO2_POL	GPIO2 polarity select

High-Performance Dual-Channel DC-DC Converter

Register Name	Description
GPIO2_PUPD	GPIO2 pull-up/pull-down enable
GPIO2_DEB[1:0]	GPIO2 input debounce time setting
GPIO2_DEB_RISE	GPIO2 input debounce rising edge enable
GPIO2_DEB_FALL	GPIO2 input debounce falling edge enable

4.2.3.4 OTP Reload (RELOAD)

Buck settings listed in [Error! Reference source not found.](#) are reloaded from CONF registers by triggering GPIO configured as RELOAD input.

The OTP reload happens at the same time for Buck1 and Buck2 settings. During reloading, Buck1/2 keep operating as configured without shut-down.

Table 19: OTP Reload Registers

Register Name	Description
CH#_VSEL	CH# output voltage and operation selection. 0: A, 1: B
CH#_A_VOUT[7:0]	CH# output voltage setting A : CH#_A_VOUT * 10 mV Setting under 0.3V is clamped to 0.3V, and setting over 1.9V is clamped to 1.9 V
CH#_B_VOUT[7:0]	CH# output voltage setting B : CH#_A_VOUT * 10 mV Setting under 0.3 V is clamped to 0.3 V, and setting over 1.9V is clamped to 1.9 V
CH#_A_MODE[1:0]	Operation mode selection 0: Force PFM 1: Force PWM. full phase 2: Force PWM with phase shedding 3: Auto mode
CH#_B_MODE[1:0]	Operation mode selection 0: Force PFM 1: Force PWM. full phase 2: Force PWM with phase shedding 3: Auto mode

4.3 Operating Modes

4.3.1 ON

DA9122 is ON when the IC_EN port is higher than V_{IH_EN} and the supply voltage is higher than V_{THR_POR} . Once enabled, the host processor can start communicating with DA9122 using the control interface, after the t_{IC_EN} delay.

4.3.2 OFF

DA9122 is OFF when the IC_EN port is lower than V_{IL_EN} . In OFF, the bucks are always disabled and LX nodes are pulled down by (typically 150 Ω) internal pull-down resistors.

4.4 I²C Communication

All features of DA9122 can be controlled with the I²C interface which is enabled or disabled in register I2C_EN.

High-Performance Dual-Channel DC-DC Converter

I2C_EN	Description
0	I ² C disable: SCL/GPIO3 and SDA/GPIO4 pins can be used as GPIO
1	I ² C enable: SCL/GPIO3 and SDA/GPIO4 pins are used as I ² C clock input and I ² C data input/output.

GPIO3 functions as the I²C clock and GPIO4 carries all the power manager bidirectional I²C data. The I²C interface is open-drain supporting multiple devices on a single line. The bus lines have to be pulled high by external pull-up resistors (2 kΩ to 20 kΩ). The standard frequency of the I²C bus is 1 MHz in fast-mode plus (FM+), 400 kHz in fast-mode, or 100 kHz in standard mode.

4.4.1 I²C Protocol

All data is transmitted across the I²C bus in eight-bit groups. To send a bit, the SDA line is driven towards the intended state while the SCL is low (a low SDA indicates a zero bit). Once the SDA has settled, the SCL line is brought high and then low. This pulse on SCL clocks the SDA bit into the receiver's shift register.

A two-byte serial protocol is used containing one byte for address and one byte data. Data and address transfer are transmitted MSB first for both read and write operations. All transmissions begin with the START condition from the master while the bus is in idle state (the bus is free). It is initiated by a high to low transition on the SDA line while the SCL is in the high state (a STOP condition is indicated by a low to high transition on the SDA line while the SCL is in the high state).



Figure 21: I²C START and STOP Condition Timing

The I²C bus is monitored for a valid slave address whenever the interface is enabled. It responds immediately when it receives its own slave address. The acknowledge is done by pulling the SDA line low during the following clock cycle (white blocks marked with A in Figure 22 and Figure 23).

The protocol for a register write from master to slave consists of a START condition, a slave address with read/write bit, and the eight-bit register address followed by eight bits of data, terminated by a STOP condition. DA9122 responds to all bytes with acknowledge (A), see Figure 22.

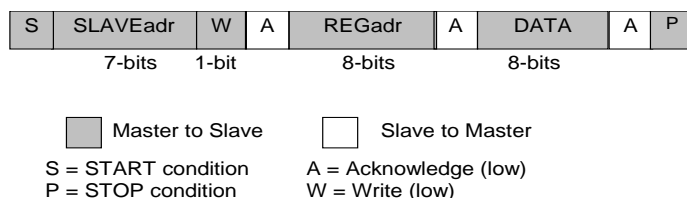


Figure 22: I²C Byte Write (SDA Line)

When the host reads data from a register it first has to write to DA9122 with the target register address and then read from DA9122 with a repeated START, or alternatively a second START, condition. After receiving the data, the host sends no acknowledge (A*) and terminates the transmission with a STOP condition, see Figure 23.

High-Performance Dual-Channel DC-DC Converter

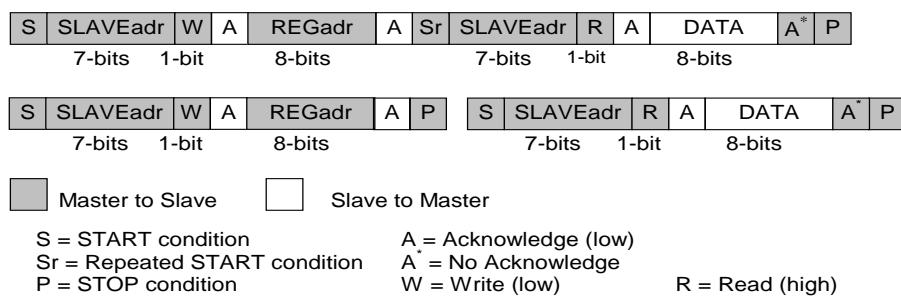


Figure 23: I²C Byte Read (SDA Line) Examples

High-Performance Dual-Channel DC-DC Converter

5 Register Definitions

5.1 Register Map

Table 20: Register Map

Addr	Register	7	6	5	4	3	2	1	0	
System Module										
System										
0x0001	SYS_STATUS_0	Reserved	Reserved	Reserved	Reserved	Reserved	SG	TEMP_CRIT	TEMP_WARN	
0x0002	SYS_STATUS_1	PG2	OV2	UV2	OC2	PG1	OV1	UV1	OC1	
0x0003	SYS_STATUS_2	Reserved	Reserved	Reserved	Reserved	Reserved	GPIO2	GPIO1	GPIO0	
0x0004	SYS_EVENT_0	Reserved	Reserved	Reserved	Reserved	Reserved	E_SG	E_TEMP_CRIT	E_TEMP_WARN	
0x0005	SYS_EVENT_1	E_PG2	E_OV2	E_UV2	E_OC2	E_PG1	E_OV1	E_UV1	E_OC1	
0x0006	SYS_EVENT_2	Reserved	Reserved	Reserved	Reserved	Reserved	E_GPIO2	E_GPIO1	E_GPIO0	
0x0007	SYS_MASK_0	Reserved	Reserved	Reserved	Reserved	Reserved	M_SG	M_TEMP_CRIT	M_TEMP_WARN	
0x0008	SYS_MASK_1	M_PG2	M_OV2	M_UV2	M_OC2	M_PG1	M_OV1	M_UV1	M_OC1	
0x0009	SYS_MASK_2	Reserved	Reserved	Reserved	Reserved	Reserved	M_GPIO2	M_GPIO1	M_GPIO0	
0x000A	SYS_MASK_3	Reserved	Reserved	Reserved	Reserved	M_VR_HO_T	M_SG_STA_T	M_PG2_STA_T	M_PG1_STA_T	
0x000B	SYS_CONFIG_0	CH1_DIS_DLY<3:0>				CH1_EN_DLY<3:0>				
0x000C	SYS_CONFIG_1	CH2_DIS_DLY<3:0>				CH2_EN_DLY<3:0>				
0x000D	SYS_CONFIG_2	Reserved	OC_LATCHOFF<1:0>		OC_DVC_MASK	PG_DVC_MASK<1:0>		Reserved	Reserved	
0x000E	SYS_CONFIG_3	Reserved	OSC_TUNE<2:0>			Reserved	Reserved	I2C_TIMEOUT	Reserved	
0x0010	SYS_GPIO0_0	Reserved	Reserved	Reserved	GPIO0_MODE<3:0>					GPIO0_OBUF
0x0011	SYS_GPIO0_1	GPIO0_D EB_FALL	GPIO0_D EB_RISE	GPIO0_DEB<1:0>		GPIO0_P UPD	GPIO0_POL	GPIO0_TRIG<1:0>		
0x0012	SYS_GPIO1_0	Reserved	Reserved	Reserved	GPIO1_MODE<3:0>					GPIO1_OBUF
0x0013	SYS_GPIO1_1	GPIO1_D EB_FALL	GPIO1_D EB_RISE	GPIO1_DEB<1:0>		GPIO1_P UPD	GPIO1_POL	GPIO1_TRIG<1:0>		
0x0014	SYS_GPIO2_0	Reserved	Reserved	Reserved	GPIO2_MODE<3:0>					GPIO2_OBUF
0x0015	SYS_GPIO2_1	GPIO2_D EB_FALL	GPIO2_D EB_RISE	GPIO2_DEB<1:0>		GPIO2_P UPD	GPIO2_POL	GPIO2_TRIG<1:0>		

High-Performance Dual-Channel DC-DC Converter

Addr	Register	7	6	5	4	3	2	1	0
Buck Control									
Buck1									
0x0020	BUCK_BUCK1_0	Reserved	CH1_SR_DVC_DWN<2:0>			CH1_SR_DVC_UP<2:0>			CH1_EN
0x0021	BUCK_BUCK1_1	Reserved	CH1_SR_SHDN<2:0>			CH1_SR_STARTUP<2:0>			CH1_PD_DIS
0x0022	BUCK_BUCK1_2	Reserved	Reserved	Reserved	Reserved	CH1_ILIM<3:0>			
0x0023	BUCK_BUCK1_3	CH1_VMAX<7:0>							
0x0024	BUCK_BUCK1_4	Reserved	Reserved	Reserved	CH1_VSE_L	CH1_B_MODE<1:0>		CH1_A_MODE<1:0>	
0x0025	BUCK_BUCK1_5	CH1_A_VOUT<7:0>							
0x0026	BUCK_BUCK1_6	CH1_B_VOUT<7:0>							
0x0027	BUCK_BUCK1_7	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved	CH1_RIPPLE_CANCEL<1:0>	
Buck2									
0x0028	BUCK_BUCK2_0	Reserved	CH2_SR_DVC_DWN<2:0>			CH2_SR_DVC_UP<2:0>			CH2_EN
0x0029	BUCK_BUCK2_1	Reserved	CH2_SR_SHDN<2:0>			CH2_SR_STARTUP<2:0>			CH2_PD_DIS
0x002A	BUCK_BUCK2_2	Reserved	Reserved	Reserved	Reserved	CH2_ILIM<3:0>			
0x002B	BUCK_BUCK2_3	CH2_VMAX<7:0>							
0x002C	BUCK_BUCK2_4	Reserved	Reserved	Reserved	CH2_VSE_L	CH2_B_MODE<1:0>		CH2_A_MODE<1:0>	
0x002D	BUCK_BUCK2_5	CH2_A_VOUT<7:0>							
0x002E	BUCK_BUCK2_6	CH2_B_VOUT<7:0>							
0x002F	BUCK_BUCK2_7	Reserved	Reserved	Reserved	Reserved	Reserved	Reserved	CH2_RIPPLE_CANCEL<1:0>	
Serialization									
0x0048	OTP_DEVICE_ID	DEV_ID<7:0>							
0x0049	OTP_VARIANT_ID	MRC<3:0>				VRC<3:0>			
0x004A	OTP_CUSTOMER_ID	CUST_ID<7:0>							
0x004B	OTP_CONFIG_ID	CONFIG_REV<7:0>							

High-Performance Dual-Channel DC-DC Converter

5.1.1 System

Table 21: SYS_STATUS_0 (0x0001)

Bit	Symbol	Description
[2]	SG	Asserted as long as the enabled buck output voltage is in range
[1]	TEMP_CRIT	Asserted as long as the thermal shutdown threshold is reached
[0]	TEMP_WARN	Asserted as long as the thermal warning threshold is reached

Table 22: SYS_STATUS_1 (0x0002)

Bit	Symbol	Description
[7]	PG2	Asserted as long as the Buck2 output voltage is in range
[6]	OV2	Asserted as long as Buck2 hitting over-voltage
[5]	UV2	Asserted as long as Buck2 hitting under-voltage
[4]	OC2	Asserted as long as Buck2 hitting over-current
[3]	PG1	Asserted as long as the Buck1 output voltage is in range
[2]	OV1	Asserted as long as Buck1 hitting over-voltage
[1]	UV1	Asserted as long as Buck1 hitting under-voltage
[0]	OC1	Asserted as long as Buck1 hitting over-current

Table 23: SYS_STATUS_2 (0x0003)

Bit	Symbol	Description
[2]	GPIO2	GPIO2 status
[1]	GPIO1	GPIO1 status
[0]	GPIO0	GPIO0 status

Table 24: SYS_EVENT_0 (0x0004)

Bit	Symbol	Description
[2]	E_SG	SG caused event. Writing 1 action clear this bit into 0 if event source has been released.
[1]	E_TEMP_CRIT	TEMP_CRIT caused event. Writing 1 action clear this bit into 0 if event source has been released.
[0]	E_TEMP_WARN	TEMP_WARN caused event. Writing 1 action clear this bit into 0 if event source has been released.

Table 25: SYS_EVENT_1 (0x0005)

Bit	Symbol	Description
[7]	E_PG2	PG2 caused event. Writing 1 action clear this bit into 0 if event source has been released.
[6]	E_OV2	OV2 caused event. Writing 1 action clear this bit into 0 if event source has been released.
[5]	E_UV2	UV2 caused event. Writing 1 action clear this bit into 0 if event source has been released.

High-Performance Dual-Channel DC-DC Converter

Bit	Symbol	Description
[4]	E_OC2	OC2 caused event. Writing 1 action clear this bit into 0 if event source has been released.
[3]	E_PG1	PG1 caused event. Writing 1 action clear this bit into 0 if event source has been released.
[2]	E_OV1	OV1 caused event. Writing 1 action clear this bit into 0 if event source has been released.
[1]	E_UV1	UV1 caused event. Writing 1 action clear this bit into 0 if event source has been released.
[0]	E_OC1	OC1 caused event. Writing 1 action clear this bit into 0 if event source has been released.

Table 26: SYS_EVENT_2 (0x0006)

Bit	Symbol	Description
[2]	E_GPIO2	GPIO2 event. Writing 1 action clear this bit into 0 if event source has been released.
[1]	E_GPIO1	GPIO1 event. Writing 1 action clear this bit into 0 if event source has been released.
[0]	E_GPIO0	GPIO0 event. Writing 1 action clear this bit into 0 if event source has been released.

Table 27: SYS_MASK_0 (0x0007)

Bit	Symbol	Description
[2]	M_SG	SG IRQ mask
[1]	M_TEMP_CRIT	TEMP_CRIT IRQ mask
[0]	M_TEMP_WARN	TEMP_WARN IRQ mask

Table 28: SYS_MASK_1 (0x0008)

Bit	Symbol	Description
[7]	M_PG2	PG2 event IRQ mask
[6]	M_OV2	OV2 event IRQ mask
[5]	M_UV2	UV2 event IRQ mask
[4]	M_OC2	OC2 event IRQ mask
[3]	M_PG1	PG1 event IRQ mask
[2]	M_OV1	OV1 event IRQ mask
[1]	M_UV1	UV1 event IRQ mask
[0]	M_OC1	OC1 event IRQ mask

Table 29: SYS_MASK_2 (0x0009)

Bit	Symbol	Description
[2]	M_GPIO2	GPIO2 IRQ mask
[1]	M_GPIO1	GPIO1 IRQ mask
[0]	M_GPIO0	GPIO0 IRQ mask

High-Performance Dual-Channel DC-DC Converter

Table 30: SYS_MASK_3 (0x000A)

Bit	Symbol	Description
[3]	M_VR_HOT	Temp warning status IRQ mask. Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1
[2]	M_SG_STAT	SG status IRQ mask. Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1
[1]	M_PG2_STAT	PG2 status IRQ mask Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1
[0]	M_PG1_STAT	PG1 status IRQ mask. Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1

Table 31: SYS_CONFIG_0 (0x000B)

Bit	Symbol	Description
[7:4]	CH1_DIS_DLY	Delay for CH1 disable. Active with GPIO configured as EN1&EN2 control and IC_EN control. Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1
		Value Description
		0x0 0
		0x1 1.0 ms
		0x2 2.0 ms
		0x3 3.0 ms
		0x4 4.0 ms
		0x5 5.0 ms
		0x6 6.0 ms
		0x7 7.0 ms
		0x8 8.0 ms
		0x9 9.0 ms
		0xA 10.0 ms
		0xB 11.0 ms
		0xC 12.0 ms
		0xD 13.0 ms
		0xE 14.0 ms
		0xF 15.0 ms
[3:0]	CH1_EN_DLY	Delay for CH1 enable. Active with GPIO configured as EN1&EN2 control and IC_EN control. Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1
		Value Description
		0x0 0
		0x1 0.5 ms
		0x2 1.0 ms
		0x3 1.5 ms

High-Performance Dual-Channel DC-DC Converter

Bit	Symbol	Description
		0x4 2.0 ms
		0x5 2.5 ms
		0x6 3.0 ms
		0x7 3.5 ms
		0x8 4.0 ms
		0x9 4.5 ms
		0xA 5.0 ms
		0xB 5.5 ms
		0xC 6.0 ms
		0xD 6.5 ms
		0xE 7.0 ms
		0xF 7.5 ms

Table 32: SYS_CONFIG_1 (0x000C)

Bit	Symbol	Description
[7:4]	CH2_DIS_DLY	Delay for CH2 disable. Active with GPIO configured as EN1&EN2 control and IC_EN control. Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1
		Value Description
		0x0 0
		0x11.0 ms
		0x22.0 ms
		0x33.0 ms
		0x44.0 ms
		0x55.0 ms
		0x66.0 ms
		0x77.0 ms
		0x88.0 ms
		0x99.0 ms
		0xA10.0 ms
		0xB11.0 ms
		0xC12.0 ms
		0xD13.0 ms
		0xE14.0 ms
0xF15.0 ms		
[3:0]	CH2_EN_DLY	Delay for CH2 enable. Active with GPIO configured as EN1&EN2 control and IC_EN control. Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1
		Value Description

High-Performance Dual-Channel DC-DC Converter

Bit	Symbol	Description
		0x0 0 0x1 0.5 ms 0x2 1.0 ms 0x3 1.5 ms 0x4 2.0 ms 0x5 2.5 ms 0x6 3.0 ms 0x7 3.5 ms 0x8 4.0 ms 0x9 4.5 ms 0xA 5.0 ms 0xB 5.5 ms 0xC 6.0 ms 0xD 6.5 ms 0xE 7.0 ms 0xF 7.5 ms

Table 33: SYS_CONFIG_2 (0x000D)

Bit	Symbol	Description
[6:5]	OC_LATCHOFF	Over-current latch-off setting. BUCK shut-down after OCP for 8 μ s/1 ms/3 ms unless disable setting. IRQ is generated unless IRQ is masked. Value Description 0x0 Latch off disable 0x1 Latch off after 8 μ s of OCP signal 0x2 Latch off after 1 ms of OCP signal 0x3 Latch off after 3 ms of OCP signal
[4]	OC_DVC_MASK	Over-current event (IRQ and latch-off feature) mask during DVC ramp-up and ramp-down for both CH1 and CH2
[3:2]	PG_DVC_MASK	Power-good mask during DVC for both CH1 and CH Value Description 0x0 No mask 0x1 Mask as not power good during DVC 0x2 Mask as power good during DVC 0x3 Reserved

Table 34: SYS_CONFIG_3 (0x000E)

Bit	Symbol	Description
[6:4]	OSC_TUNE	Tune oscillator frequency, tuned frequency = Current + OSC_TUNE * 160 kHz

High-Performance Dual-Channel DC-DC Converter

Bit	Symbol	Description	
		Value	Description
		0x3	3
		0x2	2
		0x1	1
		0x0	0
		0x7	-1
		0x6	-2
		0x5	-3
		0x4	-4
[1]	I2C_TIMEOUT	Enable automatic reset of 2-wire interface (if SDA stays low for >50 ms).	

Table 35: SYS_GPIO0_0 (0x0010)

Bit	Symbol	Description
[4:1]	GPIO0_MODE	GPIO function mode select
		Value Description
		0x0 GPIO disable
		0x1 EN1 input
		0x2 EN2 input
		0x3 EN1 & EN2 input
		0x4 DVC1 input
		0x5 DVC2 input
		0x6 DVC1 & DVC2 input
		0x7 RELOAD input
		0x8 PG1 output
		0x9 PG2 output
		0xA PG1 & PG2 output
		0xB SG output
		0xC nIRQ output
		0xD Reserved
		0xE Low output
0xF High output		
[0]	GPIO0_OBUF	GPIO output buffer select
		Value Description
		0x0 open-drain output
		0x1 push-pull output

High-Performance Dual-Channel DC-DC Converter

Table 36: SYS_GPIO0_1 (0x0011)

Bit	Symbol	Description										
[7]	GPIO0_DEB_FALL	GPI debouce falling edge										
[6]	GPIO0_DEB_RISE	GPI debounce rising edge										
[5:4]	GPIO0_DEB	<div>GPI debounce time</div> <table><tr><th>Value</th><th>Description</th></tr><tr><td>0x0</td><td>100 μs debouce</td></tr><tr><td>0x1</td><td>1 ms debouce</td></tr><tr><td>0x2</td><td>10 ms debounce</td></tr><tr><td>0x3</td><td>100 ms debounce</td></tr></table>	Value	Description	0x0	100 μ s debouce	0x1	1 ms debouce	0x2	10 ms debounce	0x3	100 ms debounce
Value	Description											
0x0	100 μ s debouce											
0x1	1 ms debouce											
0x2	10 ms debounce											
0x3	100 ms debounce											
[3]	GPIO0_PUPD	<div>GPIO pull-up/pull-down enable</div> <table><tr><th>Value</th><th>Description</th></tr><tr><td>0x0</td><td>GPI: pull-down disabled, GPO: pull-up to AVDD disabled</td></tr><tr><td>0x1</td><td>GPI: pull-down enabled, GPO: pull-up to AVDD enabled</td></tr></table>	Value	Description	0x0	GPI: pull-down disabled, GPO: pull-up to AVDD disabled	0x1	GPI: pull-down enabled, GPO: pull-up to AVDD enabled				
Value	Description											
0x0	GPI: pull-down disabled, GPO: pull-up to AVDD disabled											
0x1	GPI: pull-down enabled, GPO: pull-up to AVDD enabled											
[2]	GPIO0_POL	<div>GPIO polarity</div> <table><tr><th>Value</th><th>Description</th></tr><tr><td>0x0</td><td>GPIO is active-high</td></tr><tr><td>0x1</td><td>GPIO is active-low</td></tr></table>	Value	Description	0x0	GPIO is active-high	0x1	GPIO is active-low				
Value	Description											
0x0	GPIO is active-high											
0x1	GPIO is active-low											
[1:0]	GPIO0_TRIG	<div>GPI trigger type</div> <table><tr><th>Value</th><th>Description</th></tr><tr><td>0x0</td><td>Dual-edge triggered</td></tr><tr><td>0x1</td><td>Pos-edge triggered</td></tr><tr><td>0x2</td><td>Neg-edge triggered</td></tr><tr><td>0x3</td><td>Reserved (No trigger)</td></tr></table>	Value	Description	0x0	Dual-edge triggered	0x1	Pos-edge triggered	0x2	Neg-edge triggered	0x3	Reserved (No trigger)
Value	Description											
0x0	Dual-edge triggered											
0x1	Pos-edge triggered											
0x2	Neg-edge triggered											
0x3	Reserved (No trigger)											

Table 37: SYS_GPIO1_0 (0x0012)

Bit	Symbol	Description																
[4:1]	GPIO1_MODE	<p>GPIO function mode select. Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1</p> <table><tr><th>Value</th><th>Description</th></tr><tr><td>0x0</td><td>GPIO disable</td></tr><tr><td>0x1</td><td>EN1 input</td></tr><tr><td>0x2</td><td>EN2 input</td></tr><tr><td>0x3</td><td>EN1 & EN2 input</td></tr><tr><td>0x4</td><td>DVC1 input</td></tr><tr><td>0x5</td><td>DVC2 input</td></tr><tr><td>0x6</td><td>DVC1 & DVC2 input</td></tr></table>	Value	Description	0x0	GPIO disable	0x1	EN1 input	0x2	EN2 input	0x3	EN1 & EN2 input	0x4	DVC1 input	0x5	DVC2 input	0x6	DVC1 & DVC2 input
Value	Description																	
0x0	GPIO disable																	
0x1	EN1 input																	
0x2	EN2 input																	
0x3	EN1 & EN2 input																	
0x4	DVC1 input																	
0x5	DVC2 input																	
0x6	DVC1 & DVC2 input																	

High-Performance Dual-Channel DC-DC Converter

Bit	Symbol	Description																		
		<table><tr><td>0x7</td><td>RELOAD input</td></tr><tr><td>0x8</td><td>PG1 output</td></tr><tr><td>0x9</td><td>PG2 output</td></tr><tr><td>0xA</td><td>PG1 & PG2 output</td></tr><tr><td>0xB</td><td>SG output</td></tr><tr><td>0xC</td><td>nIRQ output</td></tr><tr><td>0xD</td><td>Reserved</td></tr><tr><td>0xE</td><td>Low output</td></tr><tr><td>0xF</td><td>High output</td></tr></table>	0x7	RELOAD input	0x8	PG1 output	0x9	PG2 output	0xA	PG1 & PG2 output	0xB	SG output	0xC	nIRQ output	0xD	Reserved	0xE	Low output	0xF	High output
0x7	RELOAD input																			
0x8	PG1 output																			
0x9	PG2 output																			
0xA	PG1 & PG2 output																			
0xB	SG output																			
0xC	nIRQ output																			
0xD	Reserved																			
0xE	Low output																			
0xF	High output																			
[0]	GPIO1_OBUF	<table><tr><td colspan="2">GPIO output buffer select. Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1</td></tr><tr><td>Value</td><td>Description</td></tr><tr><td>0x0</td><td>open-drain output</td></tr><tr><td>0x1</td><td>push-pull output</td></tr></table>	GPIO output buffer select. Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1		Value	Description	0x0	open-drain output	0x1	push-pull output										
GPIO output buffer select. Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1																				
Value	Description																			
0x0	open-drain output																			
0x1	push-pull output																			

Table 38: SYS_GPIO1_1 (0x0013)

Bit	Symbol	Description										
[7]	GPIO1_DEB_FALL	GPI debounce falling edge. Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1										
[6]	GPIO1_DEB_RISE	GPI debounce rising edge. Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1										
[5:4]	GPIO1_DEB	<div>GPI debounce time. Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1</div> <table><thead><tr><th>Value</th><th>Description</th></tr></thead><tbody><tr><td>0x0</td><td>100 μs debounce</td></tr><tr><td>0x1</td><td>1 ms debounce</td></tr><tr><td>0x2</td><td>10 ms debounce</td></tr><tr><td>0x3</td><td>100 ms debounce</td></tr></tbody></table>	Value	Description	0x0	100 μs debounce	0x1	1 ms debounce	0x2	10 ms debounce	0x3	100 ms debounce
Value	Description											
0x0	100 μs debounce											
0x1	1 ms debounce											
0x2	10 ms debounce											
0x3	100 ms debounce											
[3]	GPIO1_PUPD	<div>GPIO pull-up/pull-down enable. Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1</div> <table><thead><tr><th>Value</th><th>Description</th></tr></thead><tbody><tr><td>0x0</td><td>GPI: pull-down disabled, GPO: pull-up to AVDD disabled</td></tr><tr><td>0x1</td><td>GPI: pull-down enabled, GPO: pull-up to AVDD enabled</td></tr></tbody></table>	Value	Description	0x0	GPI: pull-down disabled, GPO: pull-up to AVDD disabled	0x1	GPI: pull-down enabled, GPO: pull-up to AVDD enabled				
Value	Description											
0x0	GPI: pull-down disabled, GPO: pull-up to AVDD disabled											
0x1	GPI: pull-down enabled, GPO: pull-up to AVDD enabled											
[2]	GPIO1_POL	<div>GPIO polarity. Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1</div> <table><thead><tr><th>Value</th><th>Description</th></tr></thead><tbody><tr><td>0x0</td><td>GPIO is active-high</td></tr><tr><td>0x1</td><td>GPIO is active-low</td></tr></tbody></table>	Value	Description	0x0	GPIO is active-high	0x1	GPIO is active-low				
Value	Description											
0x0	GPIO is active-high											
0x1	GPIO is active-low											
[1:0]	GPIO1_TRIG	GPI trigger type. Initial value is determined by CONF pin										

High-Performance Dual-Channel DC-DC Converter

Bit	Symbol	Description										
		setting at the start-up in CONF_EN = 1										
		<table><tr><th>Value</th><th>Description</th></tr><tr><td>0x0</td><td>Dual-edge triggered</td></tr><tr><td>0x1</td><td>Pos-edge triggered</td></tr><tr><td>0x2</td><td>Neg-edge triggered</td></tr><tr><td>0x3</td><td>Reserved (No trigger)</td></tr></table>	Value	Description	0x0	Dual-edge triggered	0x1	Pos-edge triggered	0x2	Neg-edge triggered	0x3	Reserved (No trigger)
Value	Description											
0x0	Dual-edge triggered											
0x1	Pos-edge triggered											
0x2	Neg-edge triggered											
0x3	Reserved (No trigger)											

Table 39: SYS_GPIO2_0 (0x0014)

Bit	Symbol	Description																																		
[4:1]	GPIO2_MODE	<div>GPIO function mode select. Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1</div> <table><tr><th>Value</th><th>Description</th></tr><tr><td>0x0</td><td>GPIO disable</td></tr><tr><td>0x1</td><td>EN1 input</td></tr><tr><td>0x2</td><td>EN2 input</td></tr><tr><td>0x3</td><td>EN1 & EN2 input</td></tr><tr><td>0x4</td><td>DVC1 input</td></tr><tr><td>0x5</td><td>DVC2 input</td></tr><tr><td>0x6</td><td>DVC1 & DVC2 input</td></tr><tr><td>0x7</td><td>RELOAD input</td></tr><tr><td>0x8</td><td>PG1 output</td></tr><tr><td>0x9</td><td>PG2 output</td></tr><tr><td>0xA</td><td>PG1 & PG2 output</td></tr><tr><td>0xB</td><td>SG output</td></tr><tr><td>0xC</td><td>nIRQ output</td></tr><tr><td>0xD</td><td>Reserved</td></tr><tr><td>0xE</td><td>Low output</td></tr><tr><td>0xF</td><td>High output</td></tr></table>	Value	Description	0x0	GPIO disable	0x1	EN1 input	0x2	EN2 input	0x3	EN1 & EN2 input	0x4	DVC1 input	0x5	DVC2 input	0x6	DVC1 & DVC2 input	0x7	RELOAD input	0x8	PG1 output	0x9	PG2 output	0xA	PG1 & PG2 output	0xB	SG output	0xC	nIRQ output	0xD	Reserved	0xE	Low output	0xF	High output
Value	Description																																			
0x0	GPIO disable																																			
0x1	EN1 input																																			
0x2	EN2 input																																			
0x3	EN1 & EN2 input																																			
0x4	DVC1 input																																			
0x5	DVC2 input																																			
0x6	DVC1 & DVC2 input																																			
0x7	RELOAD input																																			
0x8	PG1 output																																			
0x9	PG2 output																																			
0xA	PG1 & PG2 output																																			
0xB	SG output																																			
0xC	nIRQ output																																			
0xD	Reserved																																			
0xE	Low output																																			
0xF	High output																																			
[0]	GPIO2_OBUF	<div>GPIO output buffer select. Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1</div> <table><tr><th>Value</th><th>Description</th></tr><tr><td>0x0</td><td>open-drain output</td></tr><tr><td>0x1</td><td>push-pull output</td></tr></table>	Value	Description	0x0	open-drain output	0x1	push-pull output																												
Value	Description																																			
0x0	open-drain output																																			
0x1	push-pull output																																			

Table 40: SYS_GPIO2_1 (0x0015)

Bit	Symbol	Description
[7]	GPIO2_DEB_FALL	GPI debounce falling edge. Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1
[6]	GPIO2_DEB_RISE	GPI debounce rising edge. Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1

High-Performance Dual-Channel DC-DC Converter

Bit	Symbol	Description										
[5:4]	GPIO2_DEB	<div>GPI debounce time. Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1</div> <table><tr><th>Value</th><th>Description</th></tr><tr><td>0x0</td><td>100 μs debounce</td></tr><tr><td>0x1</td><td>1 ms debounce</td></tr><tr><td>0x2</td><td>10 ms debounce</td></tr><tr><td>0x3</td><td>100 ms debounce</td></tr></table>	Value	Description	0x0	100 μs debounce	0x1	1 ms debounce	0x2	10 ms debounce	0x3	100 ms debounce
Value	Description											
0x0	100 μs debounce											
0x1	1 ms debounce											
0x2	10 ms debounce											
0x3	100 ms debounce											
[3]	GPIO2_PUPD	<div>GPIO pull-up/pull-down enable. Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1</div> <table><tr><th>Value</th><th>Description</th></tr><tr><td>0x0</td><td>GPI: pull-down disabled, GPO: pull-up to AVDD disabled</td></tr><tr><td>0x1</td><td>GPI: pull-down enabled, GPO: pull-up to AVDD enabled</td></tr></table>	Value	Description	0x0	GPI: pull-down disabled, GPO: pull-up to AVDD disabled	0x1	GPI: pull-down enabled, GPO: pull-up to AVDD enabled				
Value	Description											
0x0	GPI: pull-down disabled, GPO: pull-up to AVDD disabled											
0x1	GPI: pull-down enabled, GPO: pull-up to AVDD enabled											
[2]	GPIO2_POL	<div>GPIO polarity. Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1</div> <table><tr><th>Value</th><th>Description</th></tr><tr><td>0x0</td><td>GPIO is active-high</td></tr><tr><td>0x1</td><td>GPIO is active-low</td></tr></table>	Value	Description	0x0	GPIO is active-high	0x1	GPIO is active-low				
Value	Description											
0x0	GPIO is active-high											
0x1	GPIO is active-low											
[1:0]	GPIO2_TRIG	<div>GPI trigger type. Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1</div> <table><tr><th>Value</th><th>Description</th></tr><tr><td>0x0</td><td>Dual-edge triggered</td></tr><tr><td>0x1</td><td>Pos-edge triggered</td></tr><tr><td>0x2</td><td>Neg-edge triggered</td></tr><tr><td>0x3</td><td>Reserved (No trigger)</td></tr></table>	Value	Description	0x0	Dual-edge triggered	0x1	Pos-edge triggered	0x2	Neg-edge triggered	0x3	Reserved (No trigger)
Value	Description											
0x0	Dual-edge triggered											
0x1	Pos-edge triggered											
0x2	Neg-edge triggered											
0x3	Reserved (No trigger)											

High-Performance Dual-Channel DC-DC Converter

5.1.2 Buck1

Table 41: BUCK_BUCK1_0 (0x0020)

Bit	Symbol	Description
[6:4]	CH1_SR_DVC_DWN	Voltage slew-rate for DVC ramp-down
		Value Description
		0x010 mV/8 μs
		0x110 mV/4 μs
		0x210 mV/2 μs
		0x310 mV/μs
		0x420 mV/μs
		0x5Reserved
		0x6Reserved
0x7Reserved		
[3:1]	CH1_SR_DVC_UP	Voltage slew-rate for DVC ramp-up
		Value Description
		0x010 mV/8 μs
		0x110 mV/4 μs
		0x210 mV/2 μs
		0x310 mV/μs
		0x420 mV/μs
		0x540 mV/μs
		0x6Reserved
0x7Reserved		
[0]	CH1_EN	Channel enable. Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1

Table 42: BUCK_BUCK1_1 (0x0021)

Bit	Symbol	Description
[6:4]	CH1_SR_SHDN	Voltage slew-rate during shut-down
		Value Description
		0x0 10 mV/8 μs
		0x1 10 mV/4 μs
		0x2 10 mV/2 μs
		0x3 10 mV/μs
		0x4 20 mV/μs
		0x5 Reserved
		0x6 Reserved
0x7 Immediate power-down		

High-Performance Dual-Channel DC-DC Converter

Bit	Symbol	Description
[3:1]	CH1_SR_STARTUP	Voltage slew-rate during startup
		Value Description
		0x010 mV/8 μs
		0x110 mV/4 μs
		0x210 mV/2 μs
		0x310 mV/μs
		0x420 mV/μs
		0x540 mV/μs
		0x6Reserved
		0x7Reserved
[0]	CH1_PD_DIS	Pull-down while buck is disabled. 0: enable, 1: disable

Table 43: BUCK_BUCK1_2 (0x0022)

Bit	Symbol	Description
[3:0]	CH1_ILIM	Select OCP threshold (A)
		Value Description
		0x0Reserved
		0x13.5
		0x24.0
		0x34.5
		0x45.0
		0x55.5
		0x66.0
		0x76.5
		0x87.0
		0x97.5
		0xA8.0
		0xB8.5
		0xC9.0
		0xD9.5
		0xE10.0
0xFDisable		

Table 44: BUCK_BUCK1_3 (0x0023)

Bit	Symbol	Description		
[7:0]	CH1_VMAX	VOUT max setting (V): From 0.30 V (0x1E) to 1.90 V (0xBE) in 10 mV steps. This is a read-only register. <table><tr><th>Value</th><th>Description</th></tr></table>	Value	Description
Value	Description			

High-Performance Dual-Channel DC-DC Converter

Bit	Symbol	Description
		0x1E 0.3
		0x1F 0.31
		0x20 0.32
		Continuing through...
		0x99 1.53
		To...
		0xBD 1.89
		0xBE 1.9

Table 45: BUCK_BUCK1_4 (0x0024)

Bit	Symbol	Description										
[4]	CH1_VSEL	Output voltage and operation selection: 0: A, 1: B. Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1										
[3:2]	CH1_B_MODE	Operation mode selection. Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1 <table><tr><th>Value</th><th>Description</th></tr><tr><td>0x0</td><td>Force PFM operation</td></tr><tr><td>0x1</td><td>Force PWM operation</td></tr><tr><td>0x2</td><td>Force PWM operation</td></tr><tr><td>0x3</td><td>Auto mode</td></tr></table>	Value	Description	0x0	Force PFM operation	0x1	Force PWM operation	0x2	Force PWM operation	0x3	Auto mode
Value	Description											
0x0	Force PFM operation											
0x1	Force PWM operation											
0x2	Force PWM operation											
0x3	Auto mode											
[1:0]	CH1_A_MODE	Operation mode selection. Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1 <table><tr><th>Value</th><th>Description</th></tr><tr><td>0x0</td><td>Force PFM operation</td></tr><tr><td>0x1</td><td>Force PWM operation</td></tr><tr><td>0x2</td><td>Force PWM operation</td></tr><tr><td>0x3</td><td>Auto mode</td></tr></table>	Value	Description	0x0	Force PFM operation	0x1	Force PWM operation	0x2	Force PWM operation	0x3	Auto mode
Value	Description											
0x0	Force PFM operation											
0x1	Force PWM operation											
0x2	Force PWM operation											
0x3	Auto mode											

Table 46: BUCK_BUCK1_5 (0x0025)

Bit	Symbol	Description						
[7:0]	CH1_A_VOUT	<p>Output voltage setting A: Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1 From 0.30 V (0x1E) to 1.90 V (0xBE) in steps of 10 mV (default 1.0 V) Write-protected when value is written below 0.30 V or above 1.90 V</p> <table><tr><th>Value</th><th>Description</th></tr><tr><td>0x1E</td><td>0.3</td></tr><tr><td>0x1F</td><td>0.31</td></tr></table>	Value	Description	0x1E	0.3	0x1F	0.31
Value	Description							
0x1E	0.3							
0x1F	0.31							

High-Performance Dual-Channel DC-DC Converter

Bit	Symbol	Description
		0x20 0.32 Continuing through... 0x64 1 To... 0xBC 1.88 0xBD 1.89 0xBE 1.9

Table 47: BUCK_BUCK1_6 (0x0026)

Bit	Symbol	Description																				
[7:0]	CH1_B_VOUT	<p>Output voltage setting B: Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1 From 0.30 V (0x1E) to 1.90 V (0xBE) in steps of 10 mV (default 1.0 V) Write-protected when value is written below 0.30 V or above 1.90 V</p> <table><thead><tr><th>Value</th><th>Description</th></tr></thead><tbody><tr><td>0x1E</td><td>0.3</td></tr><tr><td>0x1F</td><td>0.31</td></tr><tr><td>0x20</td><td>0.32</td></tr><tr><td colspan="2">Continuing through...</td></tr><tr><td>0x64</td><td>1</td></tr><tr><td colspan="2">To...</td></tr><tr><td>0xBC</td><td>1.88</td></tr><tr><td>0xBD</td><td>1.89</td></tr><tr><td>0xBE</td><td>1.9</td></tr></tbody></table>	Value	Description	0x1E	0.3	0x1F	0.31	0x20	0.32	Continuing through...		0x64	1	To...		0xBC	1.88	0xBD	1.89	0xBE	1.9
Value	Description																					
0x1E	0.3																					
0x1F	0.31																					
0x20	0.32																					
Continuing through...																						
0x64	1																					
To...																						
0xBC	1.88																					
0xBD	1.89																					
0xBE	1.9																					

Table 48: BUCK_BUCK1_7 (0x0027)

Bit	Symbol	Description										
[1:0]	CH1_RIPPLE_CANCEL	<div>Ripple cancel control (can be used to improve output overshoot at heavy to light load transient).</div> <table><tr><th>Value</th><th>Description</th></tr><tr><td>0x0</td><td>No ripple cancel</td></tr><tr><td>0x1</td><td>Small ripple cancel</td></tr><tr><td>0x2</td><td>Mid ripple cancel</td></tr><tr><td>0x3</td><td>Large ripple cancel</td></tr></table>	Value	Description	0x0	No ripple cancel	0x1	Small ripple cancel	0x2	Mid ripple cancel	0x3	Large ripple cancel
Value	Description											
0x0	No ripple cancel											
0x1	Small ripple cancel											
0x2	Mid ripple cancel											
0x3	Large ripple cancel											

High-Performance Dual-Channel DC-DC Converter

5.1.3 Buck2

Table 49: BUCK_BUCK2_0 (0x0028)

Bit	Symbol	Description
[6:4]	CH2_SR_DVC_DWN	Voltage slew-rate for DVC ramp-down
		Value Description
		0x010 mV/8 μs
		0x110 mV/4 μs
		0x210 mV/2 μs
		0x310 mV/μs
		0x420 mV/μs
		0x5Reserved
		0x6Reserved
0x7Reserved		
[3:1]	CH2_SR_DVC_UP	Voltage slew-rate for DVC ramp-up
		Value Description
		0x010 mV/8 μs
		0x110 mV/4 μs
		0x210 mV/2 μs
		0x310 mV/μs
		0x420 mV/μs
		0x540 mV/μs
		0x6Reserved
0x7Reserved		
[0]	CH2_EN	Channel enable. Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1

Table 50: BUCK_BUCK2_1 (0x0029)

Bit	Symbol	Description																		
[6:4]	CH2_SR_SHDN	Voltage slew-rate during power-down																		
		<table><tr><th>Value</th><th>Description</th></tr><tr><td>0x0</td><td>10 mV/8 μs</td></tr><tr><td>0x1</td><td>10 mV/4 μs</td></tr><tr><td>0x2</td><td>10 mV/2 μs</td></tr><tr><td>0x3</td><td>10 mV/μs</td></tr><tr><td>0x4</td><td>20 mV/μs</td></tr><tr><td>0x5</td><td>Reserved</td></tr><tr><td>0x6</td><td>Reserved</td></tr><tr><td>0x7</td><td>Immediate power-down</td></tr></table>	Value	Description	0x0	10 mV/8 μ s	0x1	10 mV/4 μ s	0x2	10 mV/2 μ s	0x3	10 mV/ μ s	0x4	20 mV/μs	0x5	Reserved	0x6	Reserved	0x7	Immediate power-down
		Value	Description																	
		0x0	10 mV/8 μ s																	
		0x1	10 mV/4 μ s																	
		0x2	10 mV/2 μ s																	
		0x3	10 mV/ μ s																	
		0x4	20 mV/μs																	
		0x5	Reserved																	
0x6	Reserved																			
0x7	Immediate power-down																			

High-Performance Dual-Channel DC-DC Converter

Bit	Symbol	Description
[3:1]	CH2_SR_STARTUP	Voltage slew-rate during startup
		Value Description
		0x010 mV/8 μs
		0x110 mV/4 μs
		0x210 mV/2 μs
		0x310 mV/μs
		0x420 mV/μs
		0x540 mV/μs
		0x6Reserved
0x7Reserved		
[0]	CH2_PD_DIS	Pull-down while BUCK is disabled. 0: enable, 1: disable

Table 51: BUCK_BUCK2_2 (0x002A)

Bit	Symbol	Description
[3:0]	CH2_ILIM	Select OCP threshold
		Value Description
		0x0Reserved
		0x13.5
		0x24.0
		0x34.5
		0x45.0
		0x55.5
		0x66.0
		0x76.5
		0x87.0
		0x97.5
		0xA8.0
		0xB8.5
		0xC9.0
		0xD9.5
		0xE10.0
0xFDisable		

Table 52: BUCK_BUCK2_3 (0x002B)

Bit	Symbol	Description		
[7:0]	CH2_VMAX	VOUT max setting (V): From 0.30 V (0x1E) to 1.90 V (0xBE) in steps of 10 mV This is a read-only register. <table><tr><th>Value</th><th>Description</th></tr></table>	Value	Description
Value	Description			

High-Performance Dual-Channel DC-DC Converter

Bit	Symbol	Description
		0x1E 0.3
		0x1F 0.31
		0x20 0.32
		Continuing through...
		0x64 1
		To...
		0xBC 1.88
		0xBD 1.89
		0xBE 1.9

Table 53: BUCK_BUCK2_4 (0x002C)

Bit	Symbol	Description										
[4]	CH2_VSEL	Output voltage and operation selection: 0: A, 1: B. Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1										
[3:2]	CH2_B_MODE	<div>Operation mode selection. Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1</div> <table><thead><tr><th>Value</th><th>Description</th></tr></thead><tbody><tr><td>0x0</td><td>Force PFM operation</td></tr><tr><td>0x1</td><td>Force PWM operation</td></tr><tr><td>0x2</td><td>Force PWM operation</td></tr><tr><td>0x3</td><td>Auto mode</td></tr></tbody></table>	Value	Description	0x0	Force PFM operation	0x1	Force PWM operation	0x2	Force PWM operation	0x3	Auto mode
Value	Description											
0x0	Force PFM operation											
0x1	Force PWM operation											
0x2	Force PWM operation											
0x3	Auto mode											
[1:0]	CH2_A_MODE	<div>Operation mode selection. Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1</div> <table><thead><tr><th>Value</th><th>Description</th></tr></thead><tbody><tr><td>0x0</td><td>Force PFM operation</td></tr><tr><td>0x1</td><td>Force PWM operation</td></tr><tr><td>0x2</td><td>Force PWM operation</td></tr><tr><td>0x3</td><td>Auto mode</td></tr></tbody></table>	Value	Description	0x0	Force PFM operation	0x1	Force PWM operation	0x2	Force PWM operation	0x3	Auto mode
Value	Description											
0x0	Force PFM operation											
0x1	Force PWM operation											
0x2	Force PWM operation											
0x3	Auto mode											

Table 54: BUCK_BUCK2_5 (0x002D)

Bit	Symbol	Description								
[7:0]	CH2_A_VOUT	<p>Output voltage setting A: Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1 From 0.30 V (0x1E) to 1.90 V (0xBE) in steps of 10 mV (default 1.0 V) Write-protected when value is written below 0.30 V or above 1.90 V</p> <table><tr><th>Value</th><th>Description</th></tr><tr><td>0x1E</td><td>0.3</td></tr><tr><td>0x1F</td><td>0.31</td></tr><tr><td>0x20</td><td>0.32</td></tr></table>	Value	Description	0x1E	0.3	0x1F	0.31	0x20	0.32
Value	Description									
0x1E	0.3									
0x1F	0.31									
0x20	0.32									

High-Performance Dual-Channel DC-DC Converter

Bit	Symbol	Description
		Continuing through...
		0x64 1
		To...
		0xBC 1.88
		0xBD 1.89
		0xBE 1.9

Table 55: BUCK_BUCK2_6 (0x002E)

Bit	Symbol	Description																				
[7:0]	CH2_B_VOUT	<p>Output voltage setting B: Initial value is determined by CONF pin setting at the start-up in CONF_EN = 1 From 0.30 V (0x1E) to 1.90 V (0xBE) in steps of 10 mV (default 1.0 V) Write-protected when value is written below 0.30 V or above 1.90 V</p> <table><thead><tr><th>Value</th><th>Description</th></tr></thead><tbody><tr><td>0x1E</td><td>0.3</td></tr><tr><td>0x1F</td><td>0.31</td></tr><tr><td>0x20</td><td>0.32</td></tr><tr><td colspan="2">Continuing through...</td></tr><tr><td>0x64</td><td>1</td></tr><tr><td colspan="2">To...</td></tr><tr><td>0xBC</td><td>1.88</td></tr><tr><td>0xBD</td><td>1.89</td></tr><tr><td>0xBE</td><td>1.9</td></tr></tbody></table>	Value	Description	0x1E	0.3	0x1F	0.31	0x20	0.32	Continuing through...		0x64	1	To...		0xBC	1.88	0xBD	1.89	0xBE	1.9
Value	Description																					
0x1E	0.3																					
0x1F	0.31																					
0x20	0.32																					
Continuing through...																						
0x64	1																					
To...																						
0xBC	1.88																					
0xBD	1.89																					
0xBE	1.9																					

Table 56: BUCK_BUCK2_7 (0x002F)

Bit	Symbol	Description										
[1:0]	CH2_RIPPLE_CANCEL	<div>Ripple cancel control (can be used to improve output overshoot at heavy to light load transient).</div> <table><tr><th>Value</th><th>Description</th></tr><tr><td>0x0</td><td>No ripple cancel</td></tr><tr><td>0x1</td><td>Small ripple cancel</td></tr><tr><td>0x2</td><td>Mid ripple cancel</td></tr><tr><td>0x3</td><td>Large ripple cancel</td></tr></table>	Value	Description	0x0	No ripple cancel	0x1	Small ripple cancel	0x2	Mid ripple cancel	0x3	Large ripple cancel
Value	Description											
0x0	No ripple cancel											
0x1	Small ripple cancel											
0x2	Mid ripple cancel											
0x3	Large ripple cancel											

High-Performance Dual-Channel DC-DC Converter

5.1.4 Serialization**Table 57: OTP_DEVICE_ID (0x0048)**

Bit	Symbol	Description
[7:0]	DEV_ID	Device ID

Table 58: OTP_VARIANT_ID (0x0049)

Bit	Symbol	Description
[7:4]	MRC	Mask Revision Code
[3:0]	VRC	Chip Variant Code

Table 59: OTP_CUSTOMER_ID (0x004A)

Bit	Symbol	Description
[7:0]	CUST_ID	Customer ID

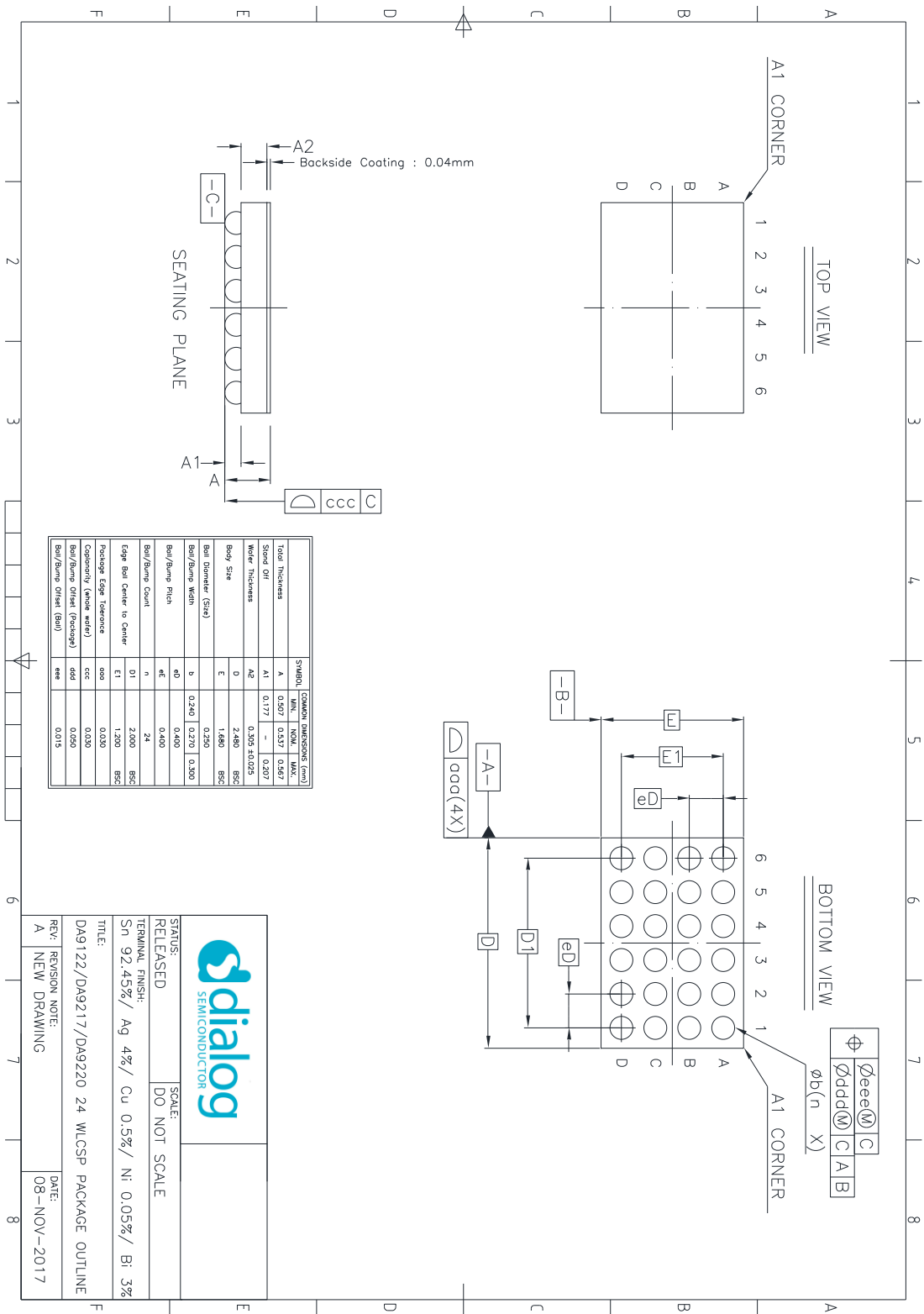
Table 60: OTP_CONFIG_ID (0x004B)

Bit	Symbol	Description
[7:0]	CONFIG_REV	OTP Variant

High-Performance Dual-Channel DC-DC Converter

6 Package Information

6.1 Package Outlines



High-Performance Dual-Channel DC-DC Converter

Figure 24: Package Outline Drawing

6.2 Moisture Sensitivity Level

The moisture sensitivity level (MSL) is an indicator for the maximum allowable time period (floor lifetime) in which a moisture sensitive plastic device, once removed from the dry bag, can be exposed to an environment with a specified maximum temperature and a maximum relative humidity before the solder reflow process. The MSL classification is defined in Table 61.

For detailed information on MSL levels refer to the IPC/JEDEC standard J-STD-020, which can be downloaded from <http://www.jedec.org>.

The DA9122 package is qualified for MSL1.

Table 61: MSL Classification

MSL Level	Floor Lifetime	Conditions
MSL 1	Unlimited	≤30 °C / 85 % RH

6.3 WLCSP Handling

Manual handling of WLCSP packages should be reduced to the absolute minimum. In cases where it is still necessary, a vacuum pick-up tool should be used. In extreme cases plastic tweezers could be used, but metal tweezers are not acceptable, since contact may easily damage the silicon chip.

Removal of a WLCSP package will cause damage to the solder balls. Therefore a removed sample cannot be reused.

WLCSP packages are sensitive to visible and infrared light. Precautions should be taken to properly shield the chip in the final product.

6.4 Soldering Information

Refer to the IPC/JEDEC standard J-STD-020 for relevant soldering information. This document can be downloaded from <http://www.jedec.org>.

High-Performance Dual-Channel DC-DC Converter

7 Ordering Information

The ordering number consists of the part number followed by a suffix indicating the packing method. For details and availability, please consult Dialog Semiconductor's [customer support portal](#) or your local sales representative.

Table 62: Ordering Information

Part Number	Package	Size (mm)	Shipment Form	Pack Quantity
DA9122-xxV72	24 WLCSP	2.5 x 1.7	T&R	4500
DA9122-xxV76	24 WLCSP	2.5 x 1.7	Waffle Tray	140
DA9122-E0V72 Standard OTP Variant $V_{OUT1} = 1.2\text{ V}$, $V_{OUT2} = 1.8\text{ V}$	24 WLCSP	2.5 x 1.7	T&R	4500
DA9122-E0V76 Standard OTP Variant $V_{OUT1} = 1.2\text{ V}$, $V_{OUT2} = 1.8\text{ V}$	24 WLCSP	2.5 x 1.7	Waffle Tray	140
DA9122-E1V72 Standard OTP Variant $V_{OUT1} = 1.0\text{ V}$, $V_{OUT2} = 1.0\text{ V}$	24 WLCSP	2.5 x 1.7	T&R	4500
DA9122-E1V76 Standard OTP Variant $V_{OUT1} = 1.0\text{ V}$, $V_{OUT2} = 1.0\text{ V}$	24 WLCSP	2.5 x 1.7	Waffle Tray	140

8 Application Information

The following recommended components are examples selected from requirements of a typical application.

8.1 Capacitor Selection

Ceramic capacitors are used as bypass capacitors at all VDD and output rails. When selecting a capacitor, especially for types with high capacitance at smallest physical dimension, the DC bias characteristic has to be taken into account.

Table 63: Recommended Capacitor Types

Application	Value	Size	Temp. Char.	Tol. (%)	V-Rate	Type
VOUT output bypass	10 μF	0402	X5R $\pm 15\%$	± 20	6.3 V	Murata GRM155R60J106ME15
PVDDx bypass	10 μF	0603	X5R $\pm 15\%$	± 20	25 V	Murata GRM188R61E106MA73
AVDD bypass	1 μF	0402	X5R $\pm 15\%$	± 10	10 V	Murata GRM155R61A105KE15

High-Performance Dual-Channel DC-DC Converter

8.2 Inductor Selection

Inductors should be selected based on the following parameters:

- Rated maximum current
Usually a coil provides two current limits: ISAT specifies the maximum current at which the inductance drops by 30 % of the nominal value, and IMAX is defined by the maximum power dissipation and is applied to the effective current.
- DC resistance
Critical for the converter efficiency and should therefore be minimized.

Table 64: Recommended Inductor Types

Value (μH)	Size (mm)	IMAX (DC) (A)	ISAT (A)	Tol. (%)	DC Resistance (mΩ)	Type
0.1	2.0 x 1.6 x 1.0	6.5	9.0	±20	11.5	Cyntec HTEN20161T-R10MDR
0.1	1.6 x 0.8 x 1.0	5.2	6.5	±20	17	Taiyo Yuden MEKK1608TR10M
0.1	1.6 x 0.8 x 0.8	4.1	9.4	±20	19	Taiyo Yuden MCHK1608TR10MJN
0.11	2.0 x 1.25 x 0.8	5.8	6.9	±20	9.1	Taiyo Yuden MCHK2012TR11MKG
0.1	2.5 x 2.0 x 1.2	12	13	±20	4	TDK TFM252012ALMAR10MT
0.1	1.6 x 0.8 x 0.95	3.8	4.3	±20	15	Tokyo Coil Engineering TFP160810M-R10N
0.11	2.0 x 1.6 x 0.6	3.0	6.0	±20	24	Würth Elektronik WE-PMMI 744 799 771 11

High-Performance Dual-Channel DC-DC Converter

Revision History

Revision	Date	Description
2.2	15-Feb-2022	Modification: <ul style="list-style-type: none"> Rebranded to Renesas
2.1	17-Sep-2020	Modification: <ul style="list-style-type: none"> Section 4.2.3.4: Added new section Section 8.1: Updated Table 64
2.0	18-Jul-2019	Modification: <ul style="list-style-type: none"> Key Features: Updated ambient temperature range Section 3.2: Updated T_A Max value Section 3.9: Added typical performance graphs Section 7: Updated Table 62: Ordering Information
1.1	07-Mar-2019	Modifications: <ul style="list-style-type: none"> Section 3.5: Updated Buck t_{BUCK_EN} parameter condition and value, RPD parameter description Section 3.7 Updated R_{PD} and R_{PU} parameter values Section 8.2: Updated Table 64: Recommended Inductor Types Removed watermark
1.0	02-Oct-2018	Modifications: <ul style="list-style-type: none"> Section 3.2: Corrected T_A Max value Section 3.5: Updated Buck $V_{OUT_TR_LINE}$, $V_{OUT_TR_LD_1PH}$, and $I_{Q_PFM_1PH}$ parameter descriptions Section 5.1.2: Updated BUCK_BUCK1_4 register description Section 5.1.3: Updated BUCK_BUCK2_4 register description
0.3	28-Sep-2018	Modifications: <ul style="list-style-type: none"> Section 3.5: Updated Buck R_{ON_PMOS} and R_{ON_NMOS} parameter values Section 0: Updated V_{THR_POR} parameter and added $V_{THR_POR_HYS}$ parameter
0.2	10-Jul-2018	Modifications: <ul style="list-style-type: none"> System Diagram: Added , Figure 2, and renamed Figure 3 Section 2: Updated Table 1: Pin Description Section 3.1: Updated V_{SYS} and V_{PIN} Max values and moved note to Section 3.3.1 Section 3.2: Added V_{PIN}, corrected T_A Max value, and updated note Section 3.3.1: Updated thermal ratings Section 3.3.2: Updated power dissipation and added Figure 5: 24WLCSP Power Derating Curve Section 3.5: Updated Buck electrical characteristics Section 0: Added I_{IN_OFF} and I_{IN_ON} parameters Section 4.1: Updated DC-DC buck converter description Section 4.1.2: Removed mention of phase shedding Section 4.1.4: Renamed section to Soft Start-Up and Shutdown Section 4.2.3.2: Added Figure 20: Power Good (PG) and System Good (SG) Section 5.1: Updated register map Section 5.1.2: Updated BUCK_BUCK1_2 register description and added BUCK_BUCK1_7 register Section 5.1.3: Updated BUCK_BUCK2_2 register description and

High-Performance Dual-Channel DC-DC Converter

Revision	Date	Description
		added BUCK_BUCK2_7 register • Section 5.1.4: Updated MRC bit (register OTP_VARIANT_ID) reset value
		• Section 7: Added part numbers • Section 8.2: Updated Table 64: Recommended Inductor Types
0.1	19-Feb-2018	Initial version.

Status Definitions

Revision	Datasheet Status	Product Status	Definition
1.<n>	Target	Development	This datasheet contains the design specifications for product development. Specifications may be changed in any manner without notice.
2.<n>	Preliminary	Qualification	This datasheet contains the specifications and preliminary characterization data for products in pre-production. Specifications may be changed at any time without notice in order to improve the design.
3.<n>	Final	Production	This datasheet contains the final specifications for products in volume production. The specifications may be changed at any time in order to improve the design, manufacturing and supply. Major specification changes are communicated via Customer Product Notifications. Datasheet changes are communicated via www.dialog-semiconductor.com .
4.<n>	Obsolete	Archived	This datasheet contains the specifications for discontinued products. The information is provided for reference only.

RoHS Compliance

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